

TOF status and future

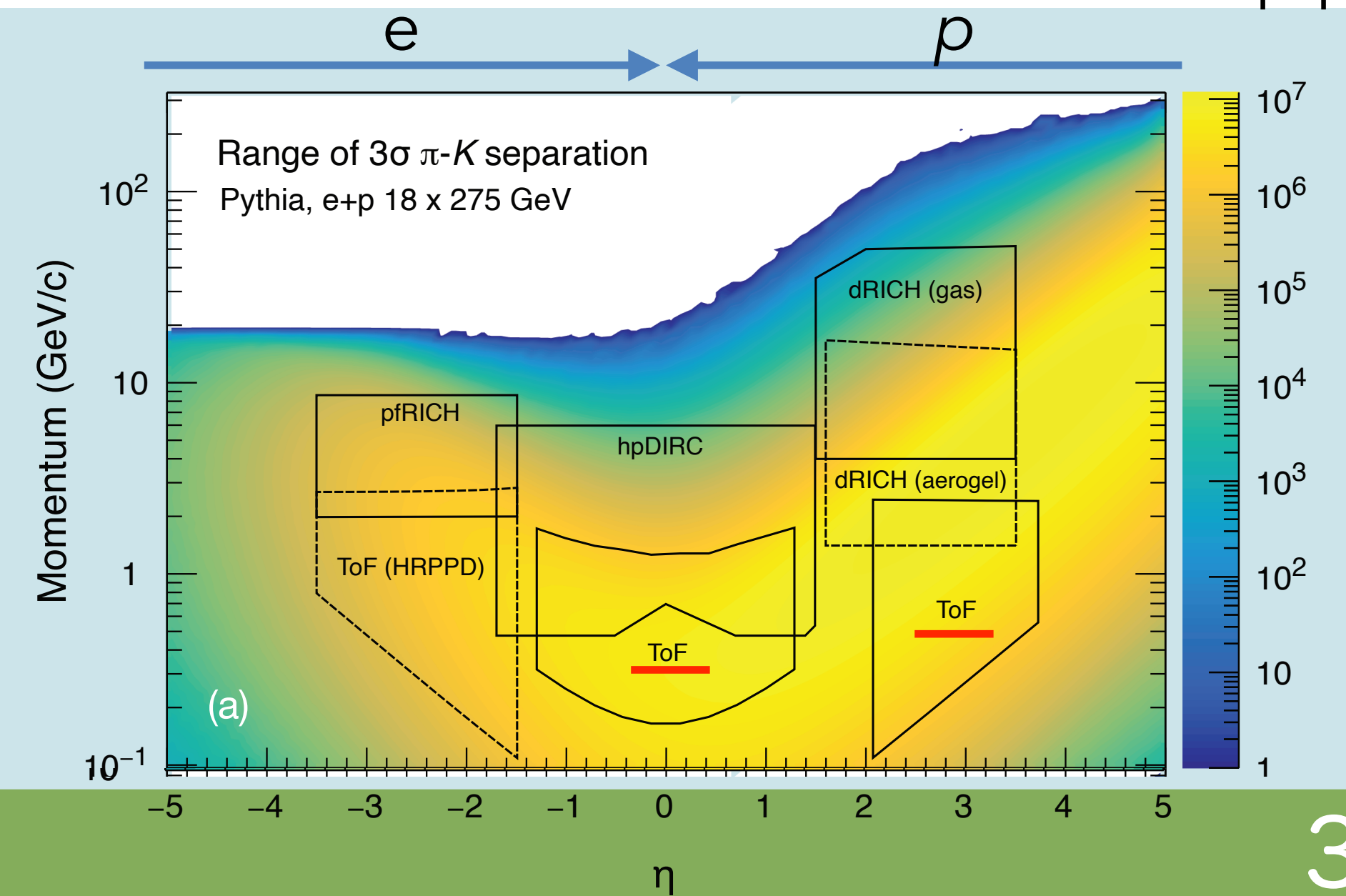
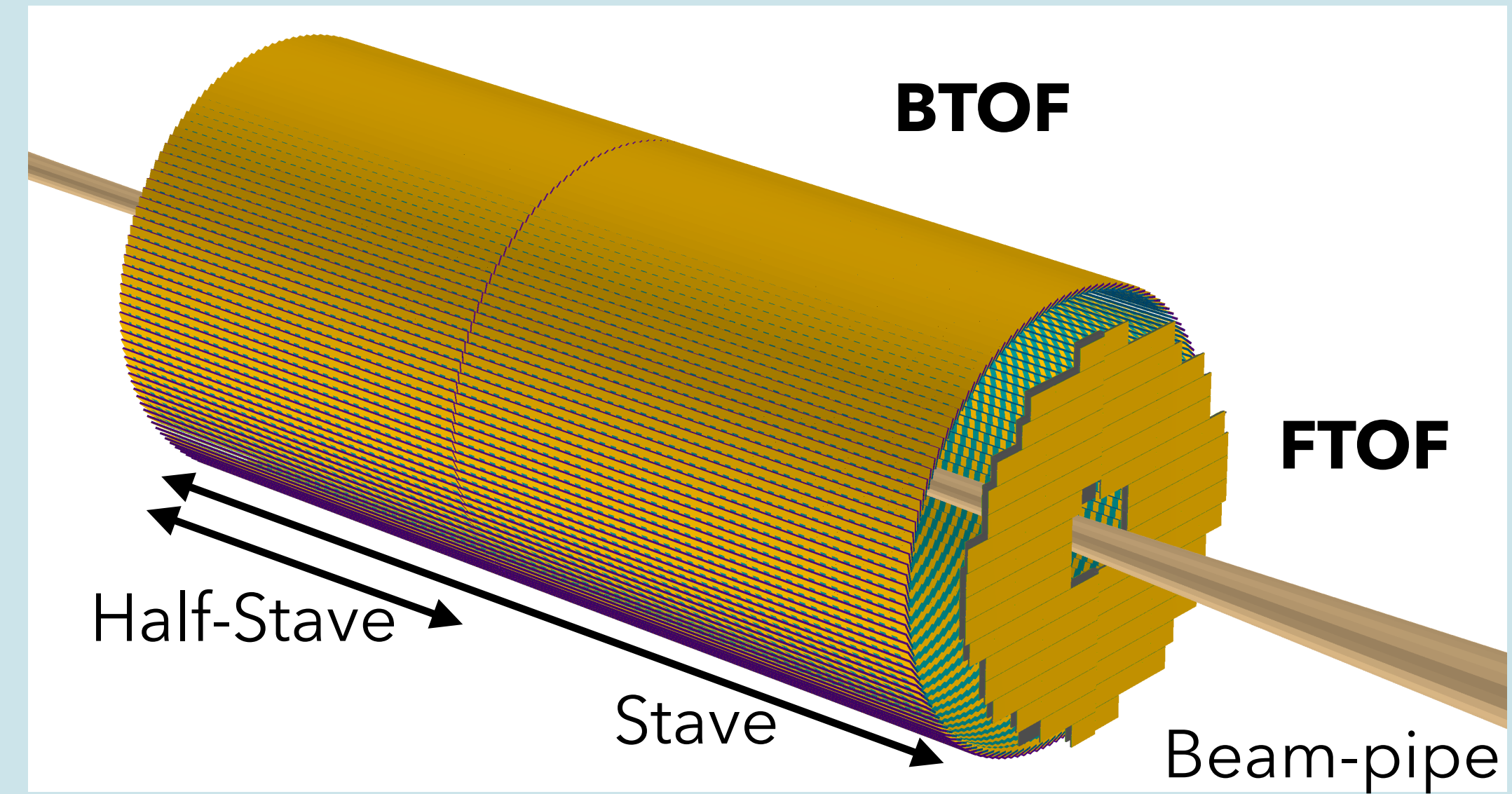
Satoshi Yano (Hiroshima University)

The ePIC Collaboration meeting @ Villa Mondragone

24/01/2025

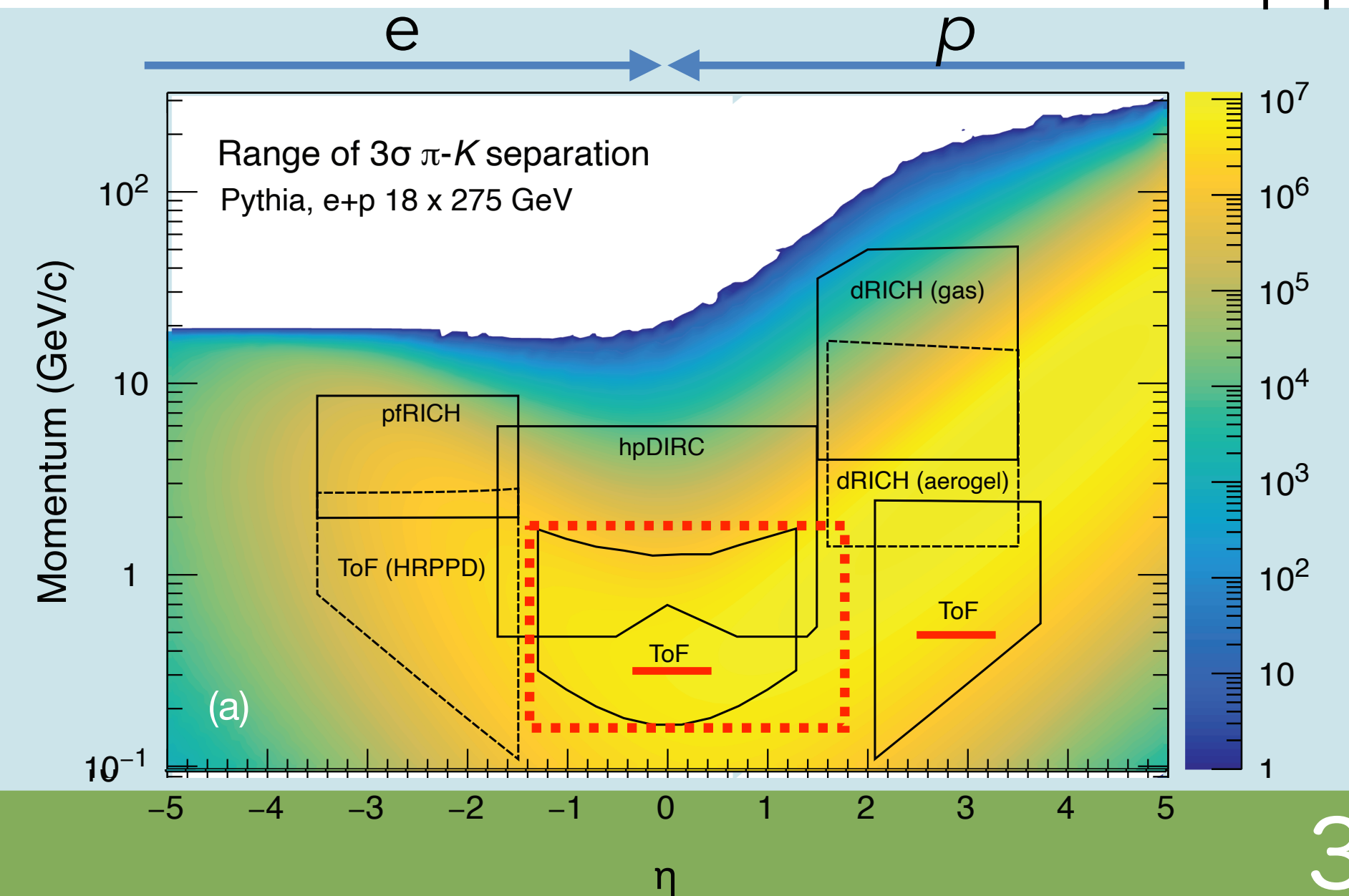
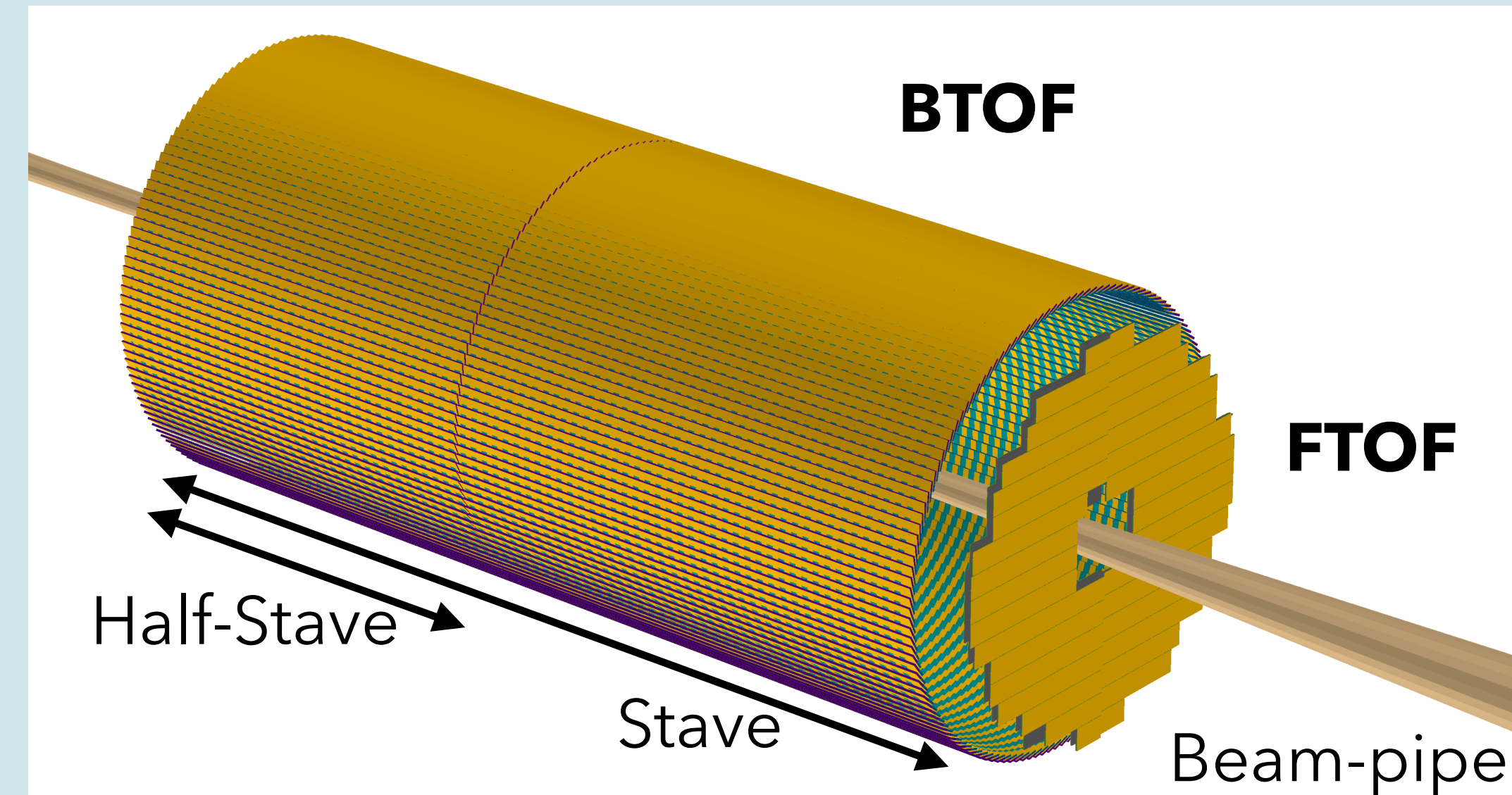
AC-LGAD TOF

- Two types of AC-LGAD TOF, BTOF and FTOF, are installed for the low-p PID
 - Complementary to the Cherenkov detectors



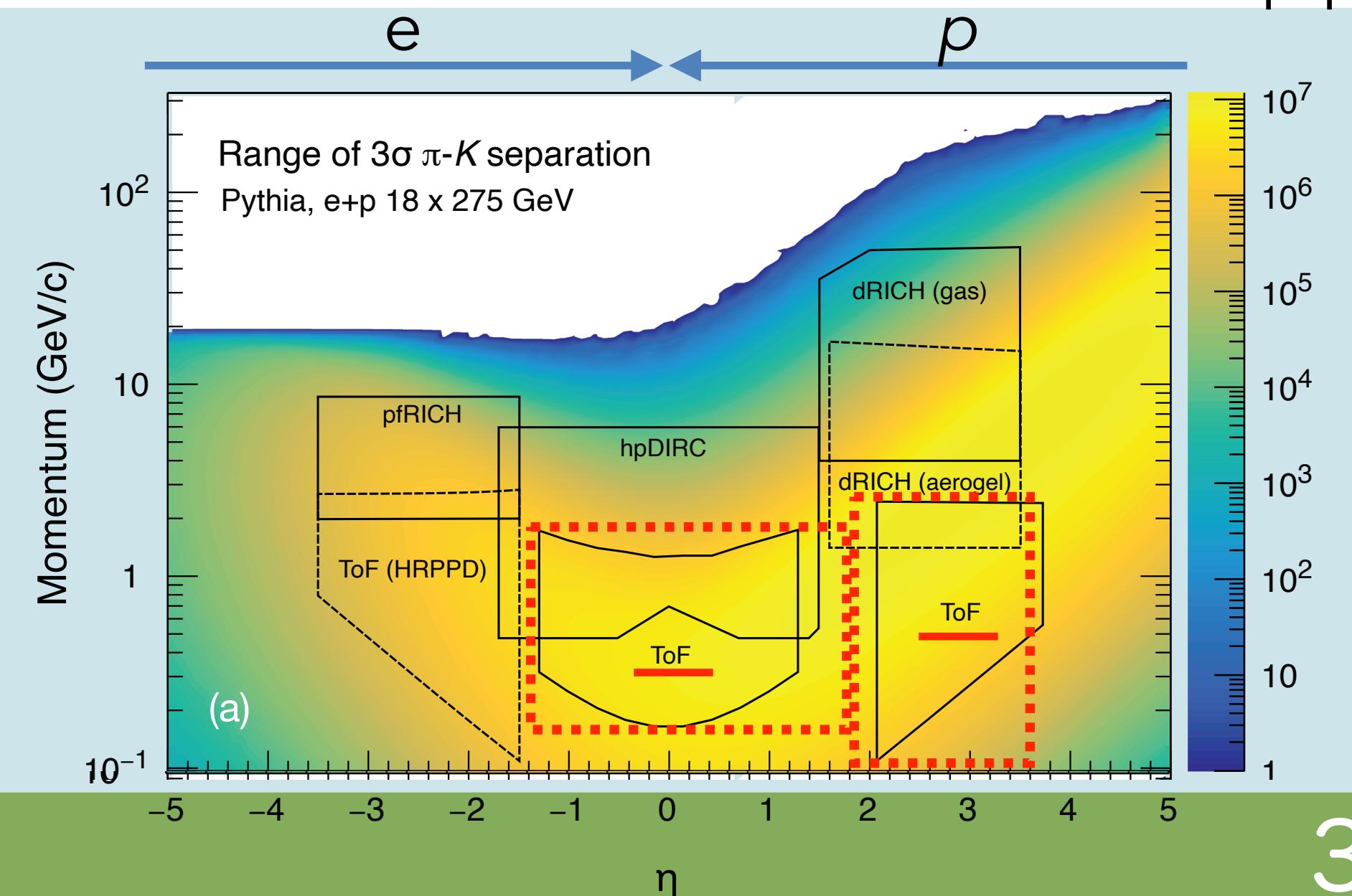
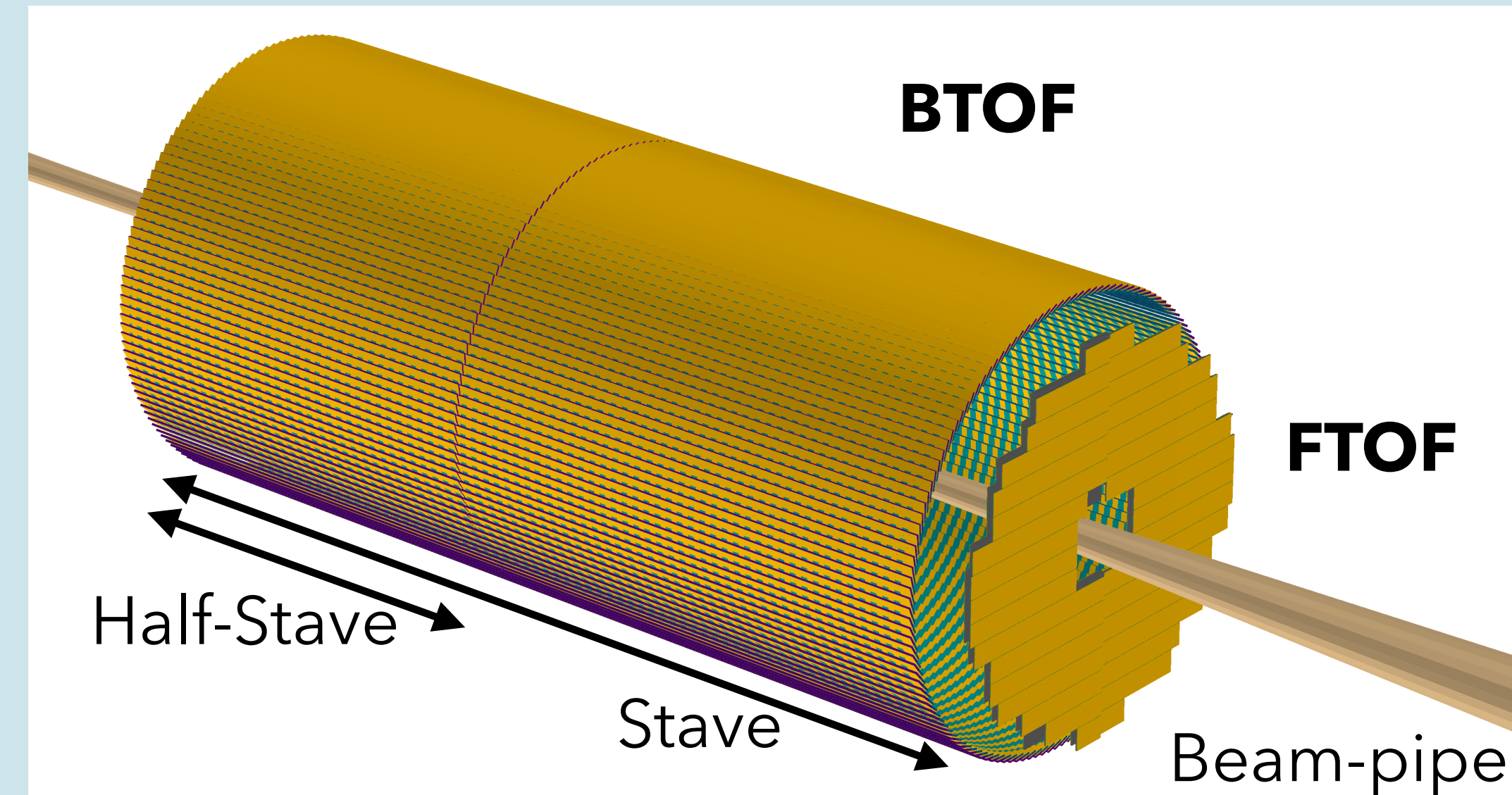
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 - Complementary to the Cherenkov detectors
- BTOF covers mid-rapidity ($-1.33 < \eta < 1.74$) composed of tilted 144 staves (288 half-staves)
 - π/K separation below 1.2 GeV/c is performed
 - Strip-type AC-LGAD sensor is used
 - It is placed at ~ 64 cm from the beam-pipe



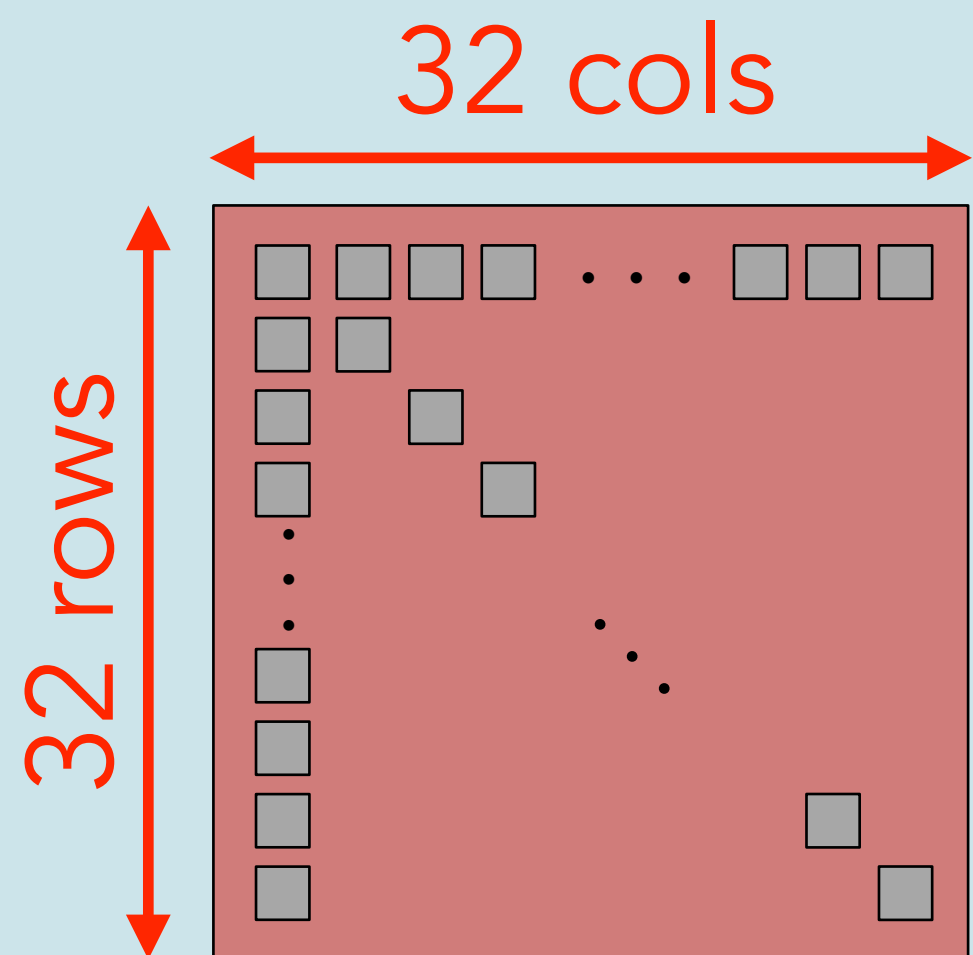
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 - π/K separation below 1.2 GeV/c is performed
 - Strip-type AC-LGAD sensor is used
 - It is placed at ~ 64 cm from the beam-pipe
- FTOF covers forward-rapidity ($1.84 < \eta < 3.61$), hadron going direction
 - π/K separation below 2.5 GeV/c is performed
 - Pixel-type AC-LGAD sensor is used



Baseline of sensor design

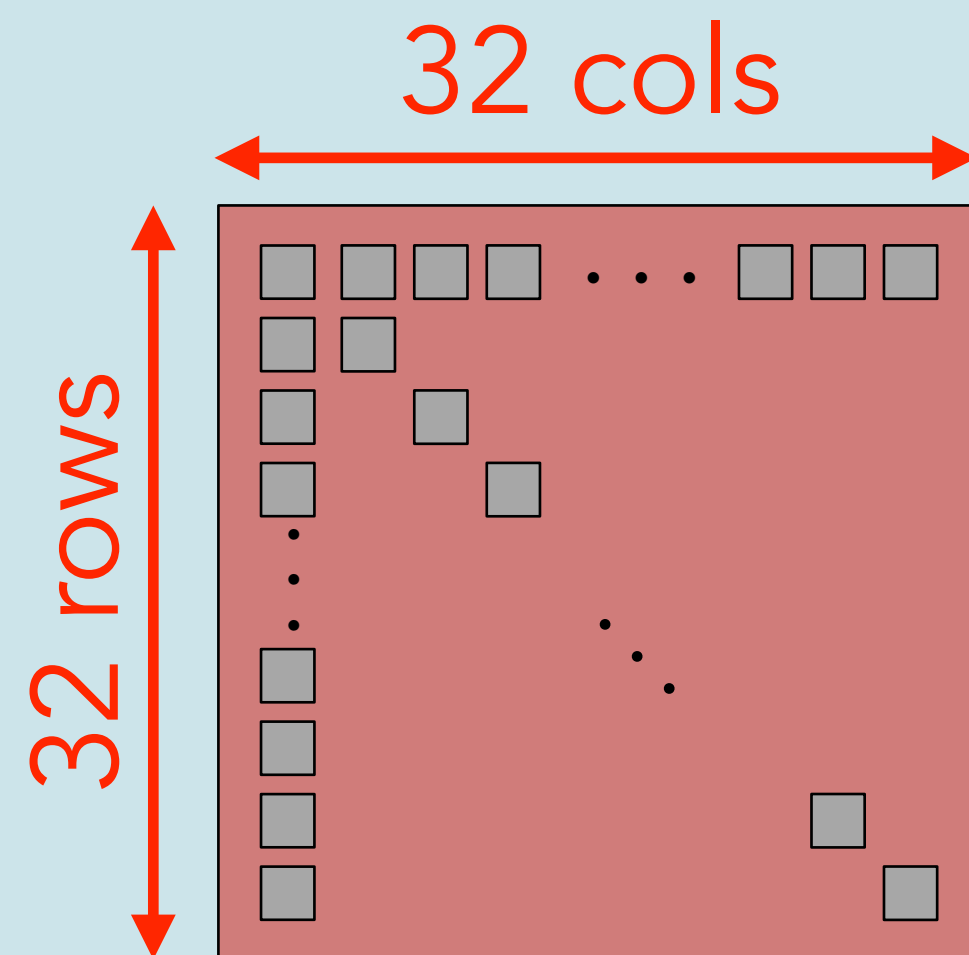
- **Pixel-type** AC-LGAD sensor, $1.6 \times 1.6 \text{ cm}^2$ sensor size with $0.5 \times 0.5 \text{ mm}^2$ metals, is used in **FTOF**
- The readout metal geometry is 32×32 and 1024 channels in total each
- 1 ASIC (2D 32×32) is attached to the one sensor



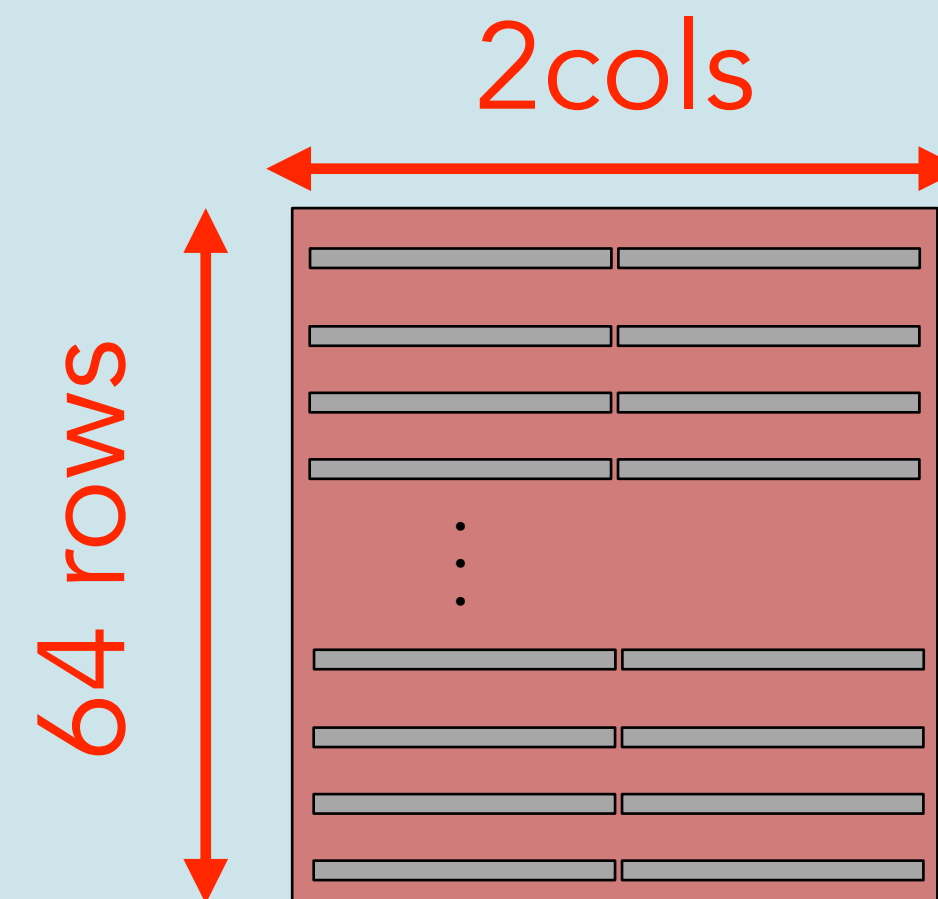
- FTOF pixel sensor
 - **3632 sensors**
 - **1.1 m²**
 - **3.6 M readout channels**

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- **Strip-type** sensor, ~~$3.2 \times 4 \text{ cm}^2$~~ **$3.2 \times 2 \text{ cm}^2$** sensor size with $0.5 \times 10 \text{ mm}^2$ metals with 0.5 mm pitch, is used in **BTOF**
- The readout metal geometry is ~~$64 \times 2 = 256$~~ **$64 \times 2 = 128$** channels in total each
- ~~2~~ **1** ASICs are attached to each sensor with wire bonding



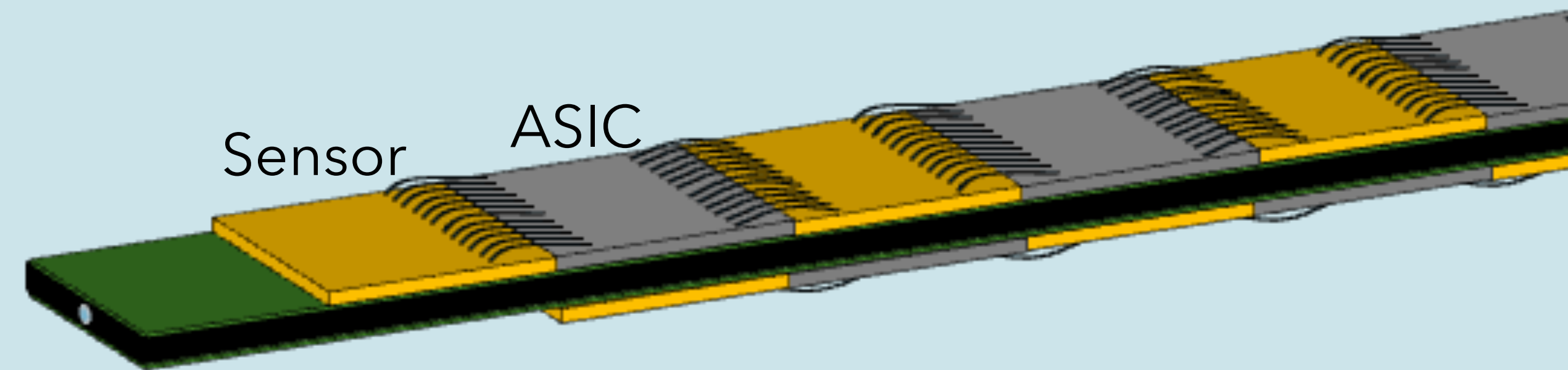
- FTOF pixel sensor
 - **3632 sensors**
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- BTOF strip sensor
 - **18432 sensors**
 - **12 m²**
 - **2.4 M readout channels**

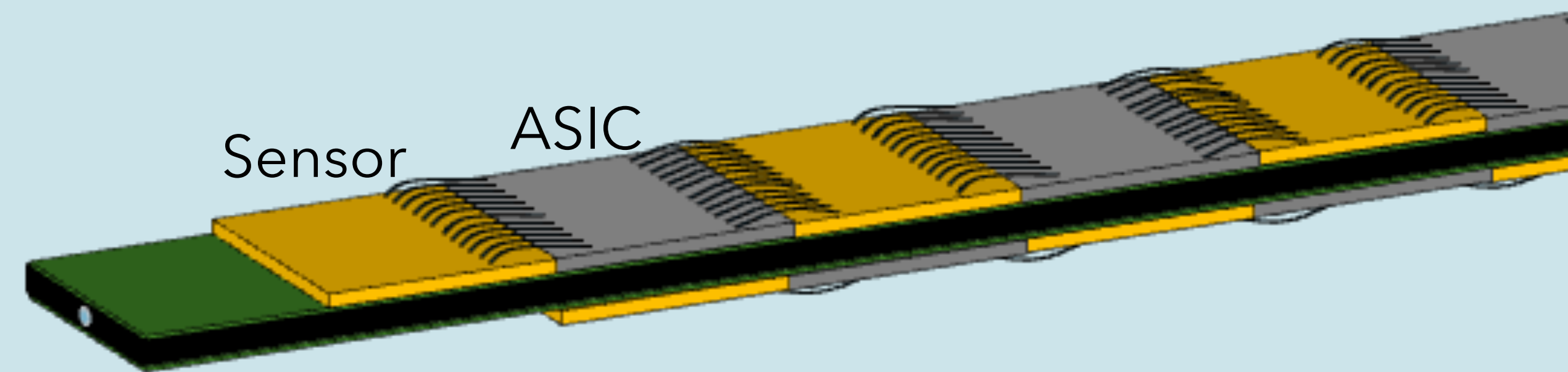
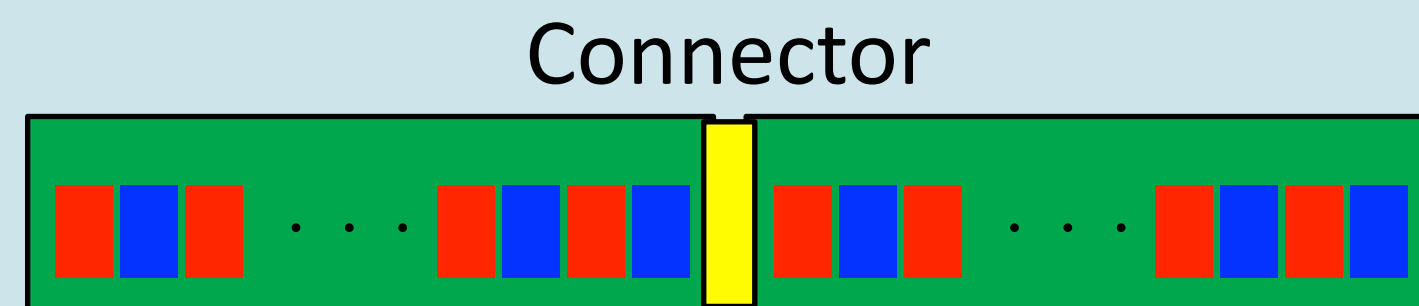
Baseline of stave structure

- The double-side sensor structure is the baseline for BTOF
 - Due to readout geometry and efficient cooling ACISs



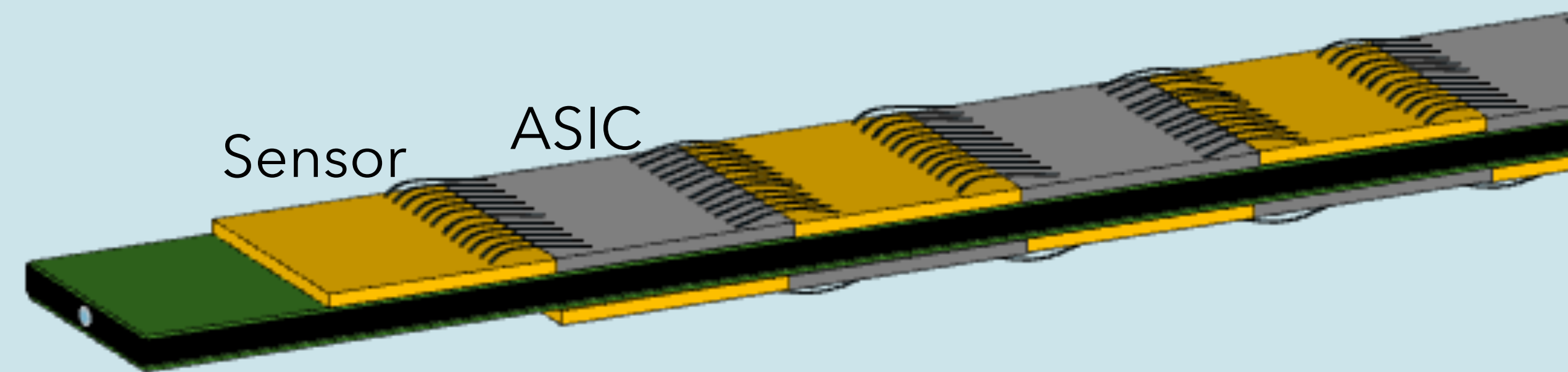
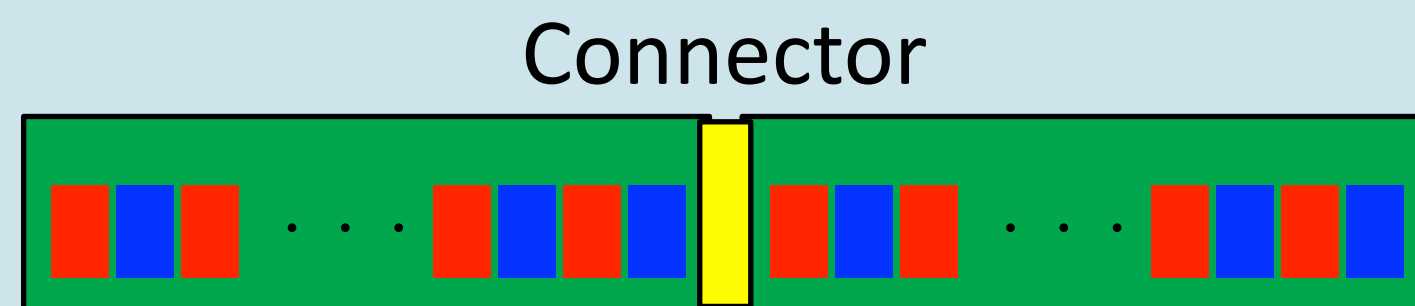
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- Development of the long (135cm) and low material FPC is very, very challenging
 - A total material budget of $\sim 0.7\%$ X/X0 is the current target (2~3% X/X0 in total)
 - We start thinking about the feasibility of using shortened pieces connecting with several bonding techniques



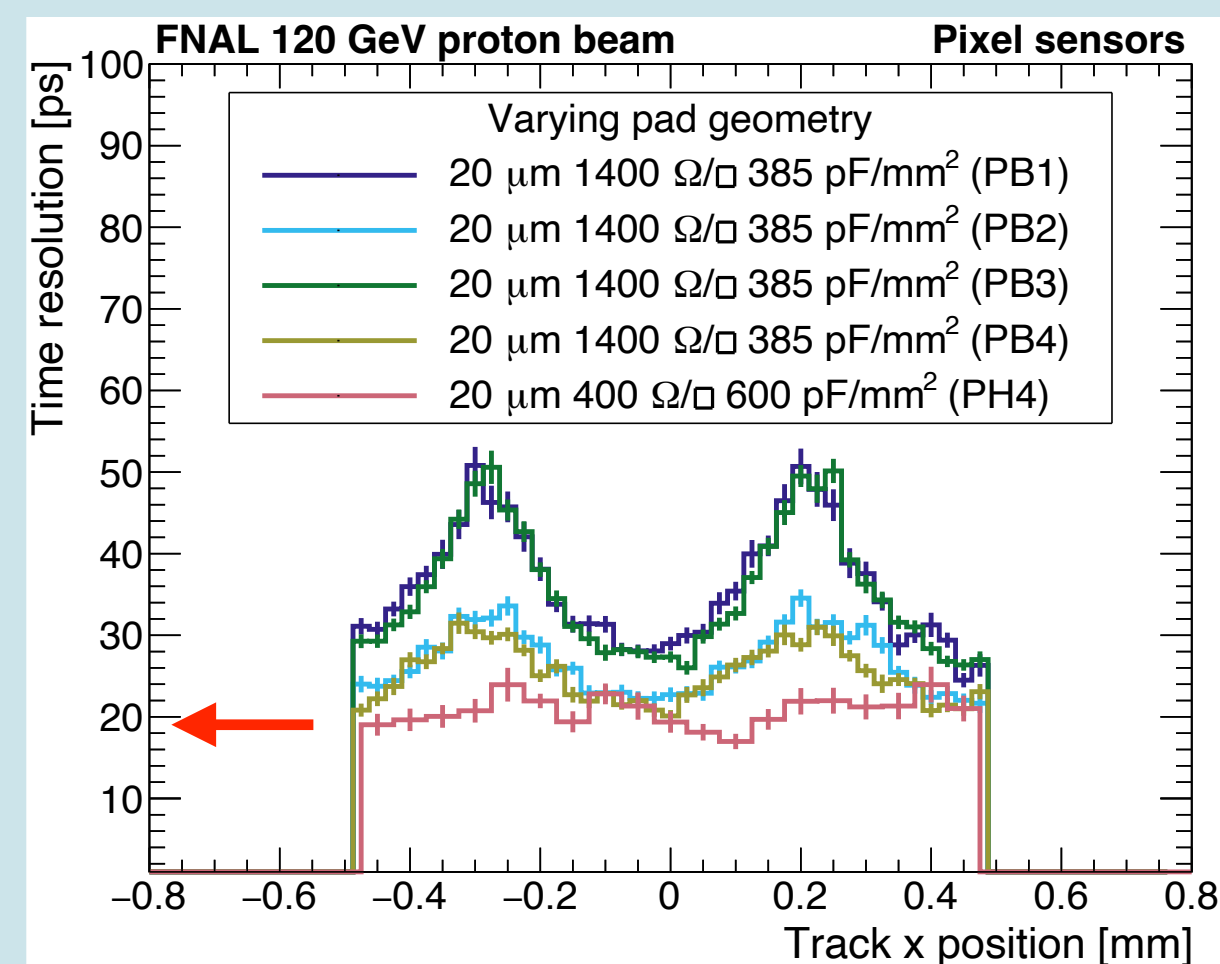
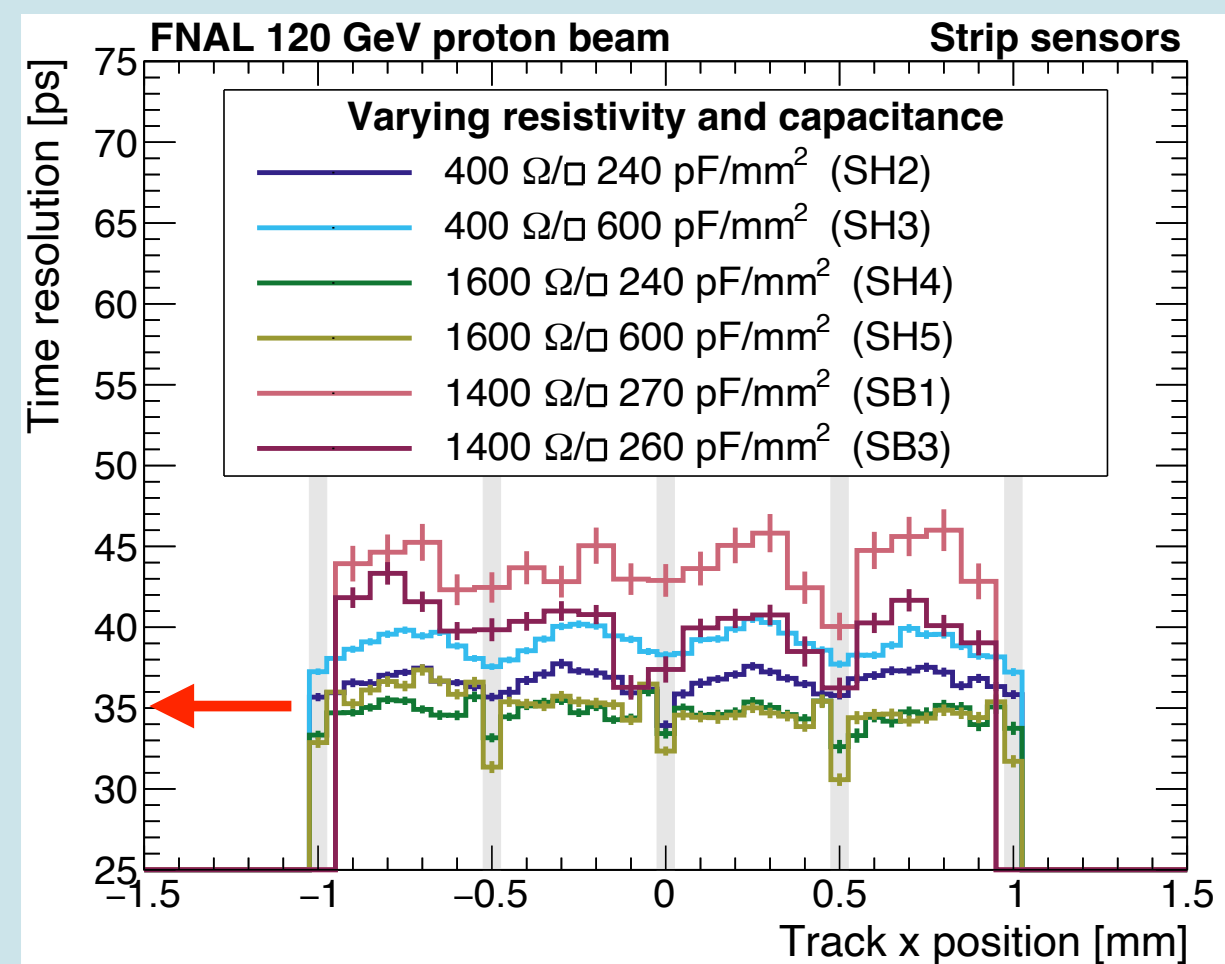
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 - We start thinking about the feasibility of using shortened pieces connecting with several bonding techniques
- The material budget effect on the hpDIRC PID performance is under evaluation
 - We discussed how to evaluate the angle resolution on hpDIRC
 - The Tracklet method of BTOF and MPGD hits may be the smallest effects by BTOF material



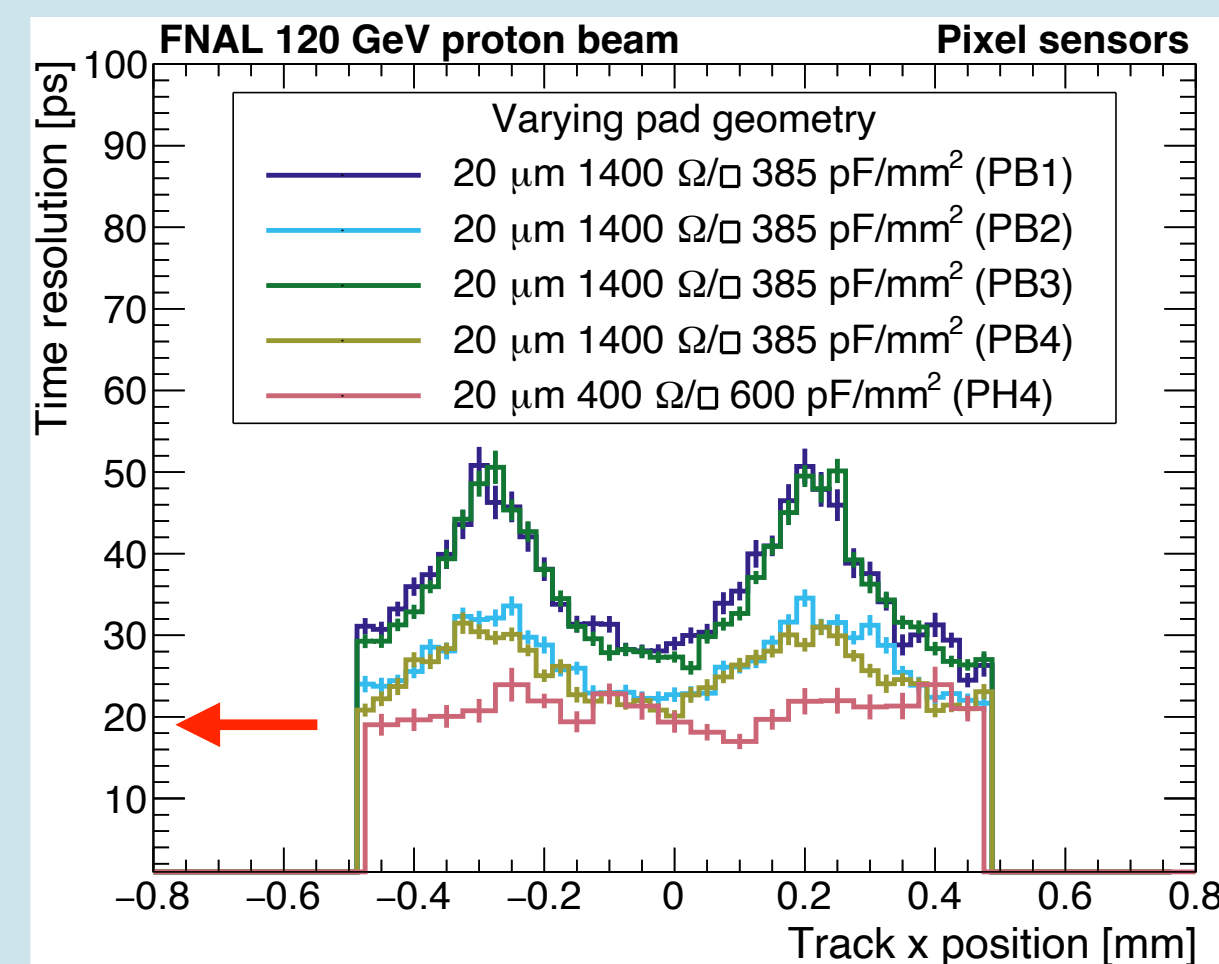
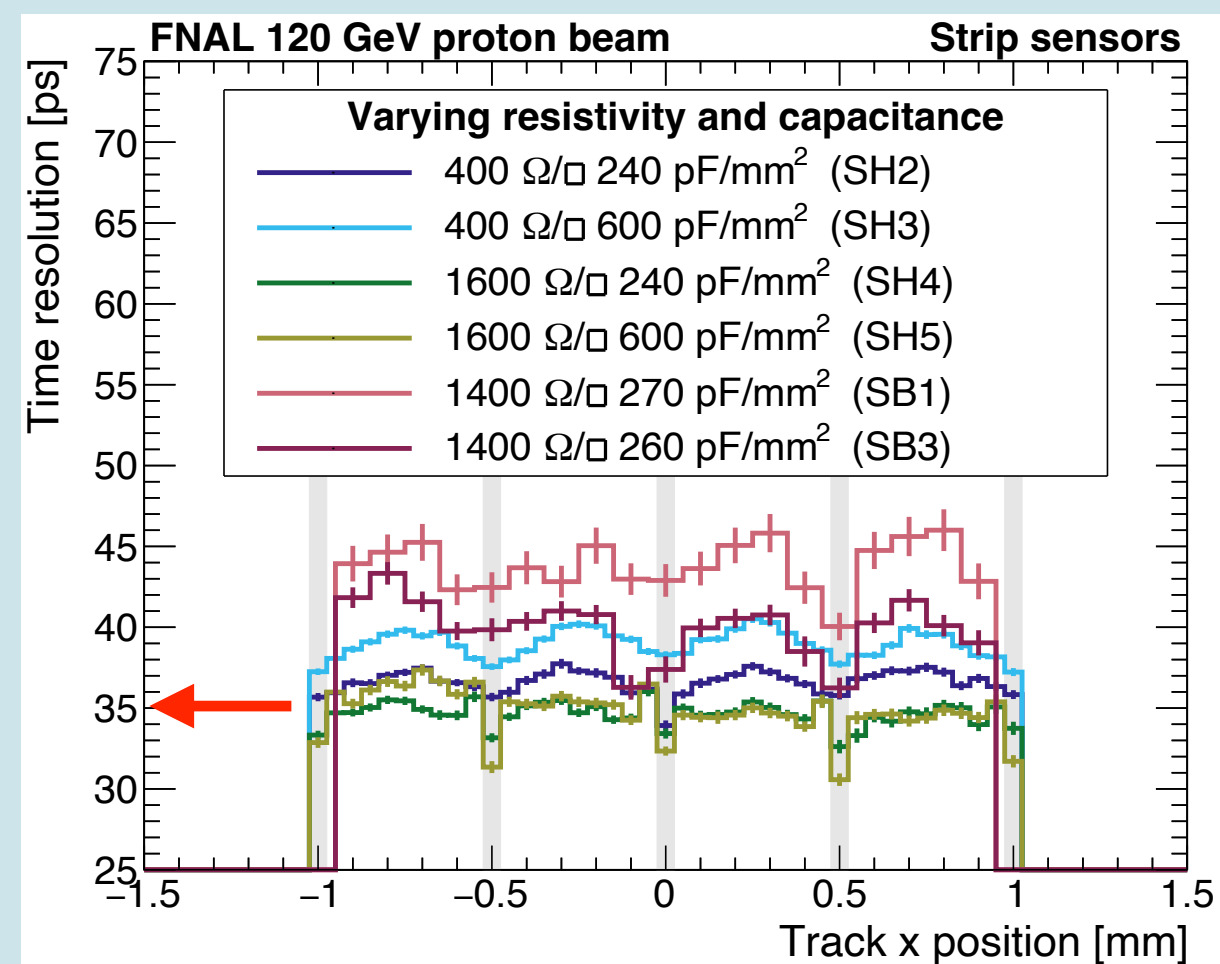
PID momentum range covered by TOF

- The best timing resolution is ~ 35 ps and ~ 20 ps for strip and pixel sensor, respectively



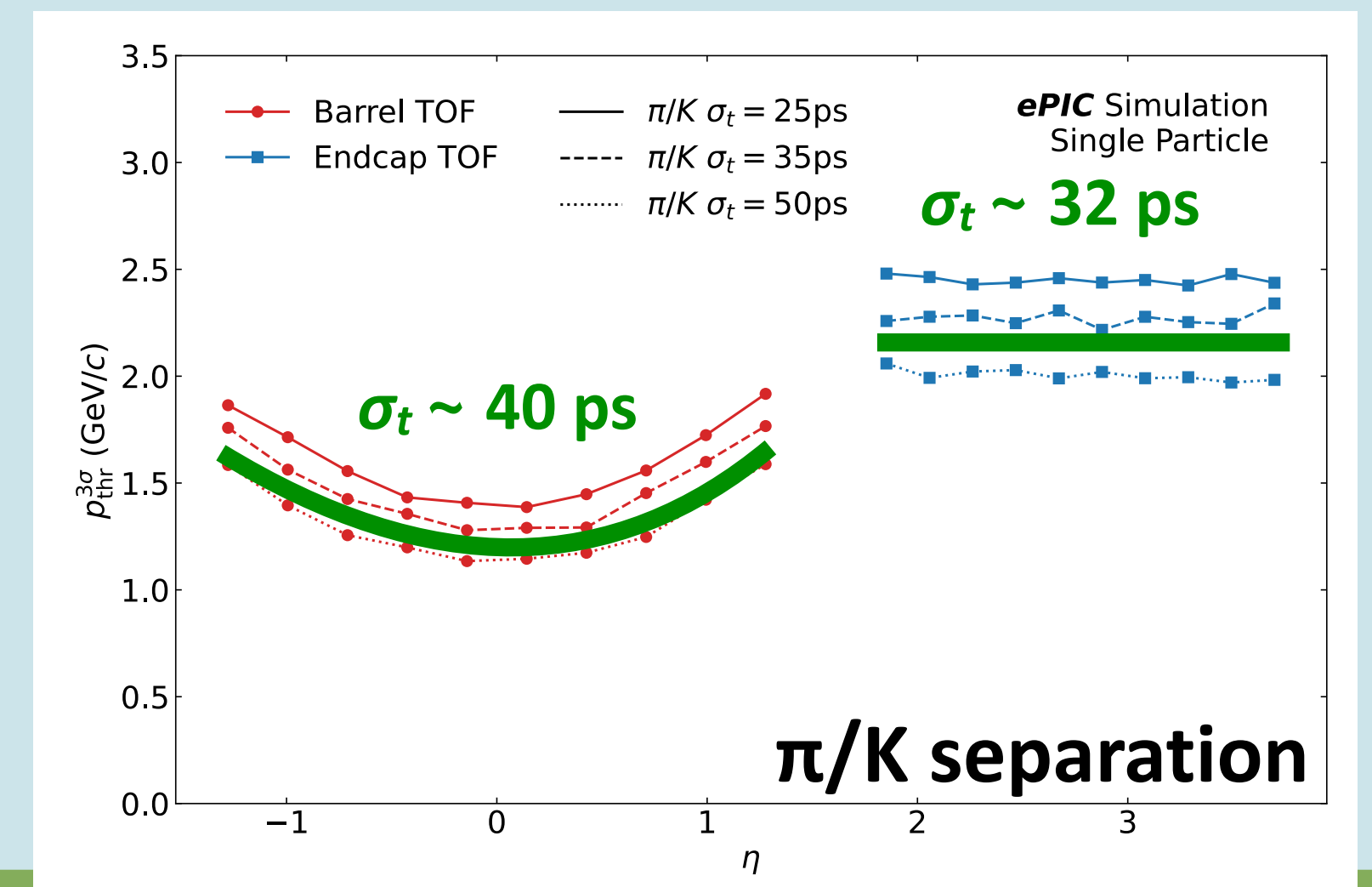
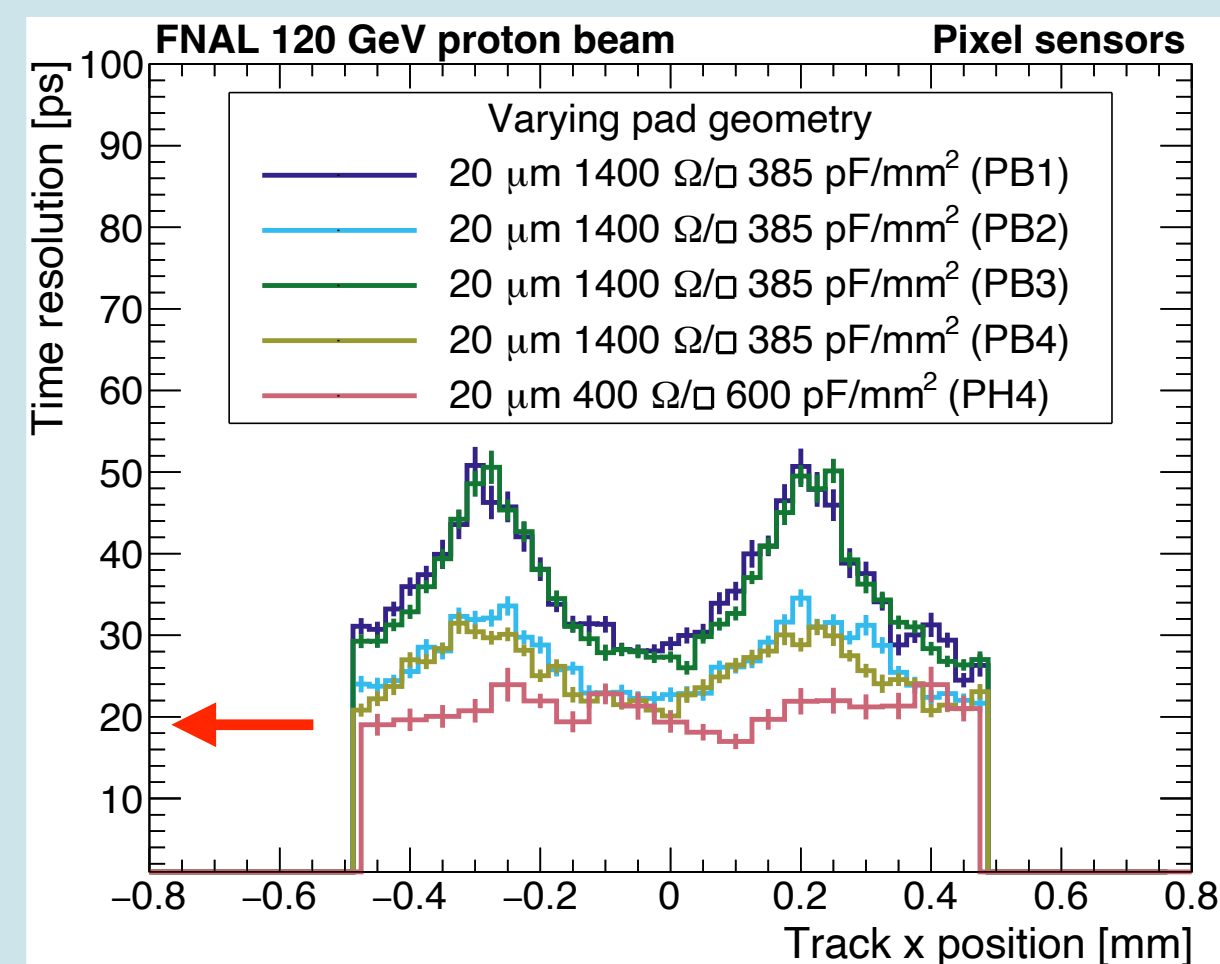
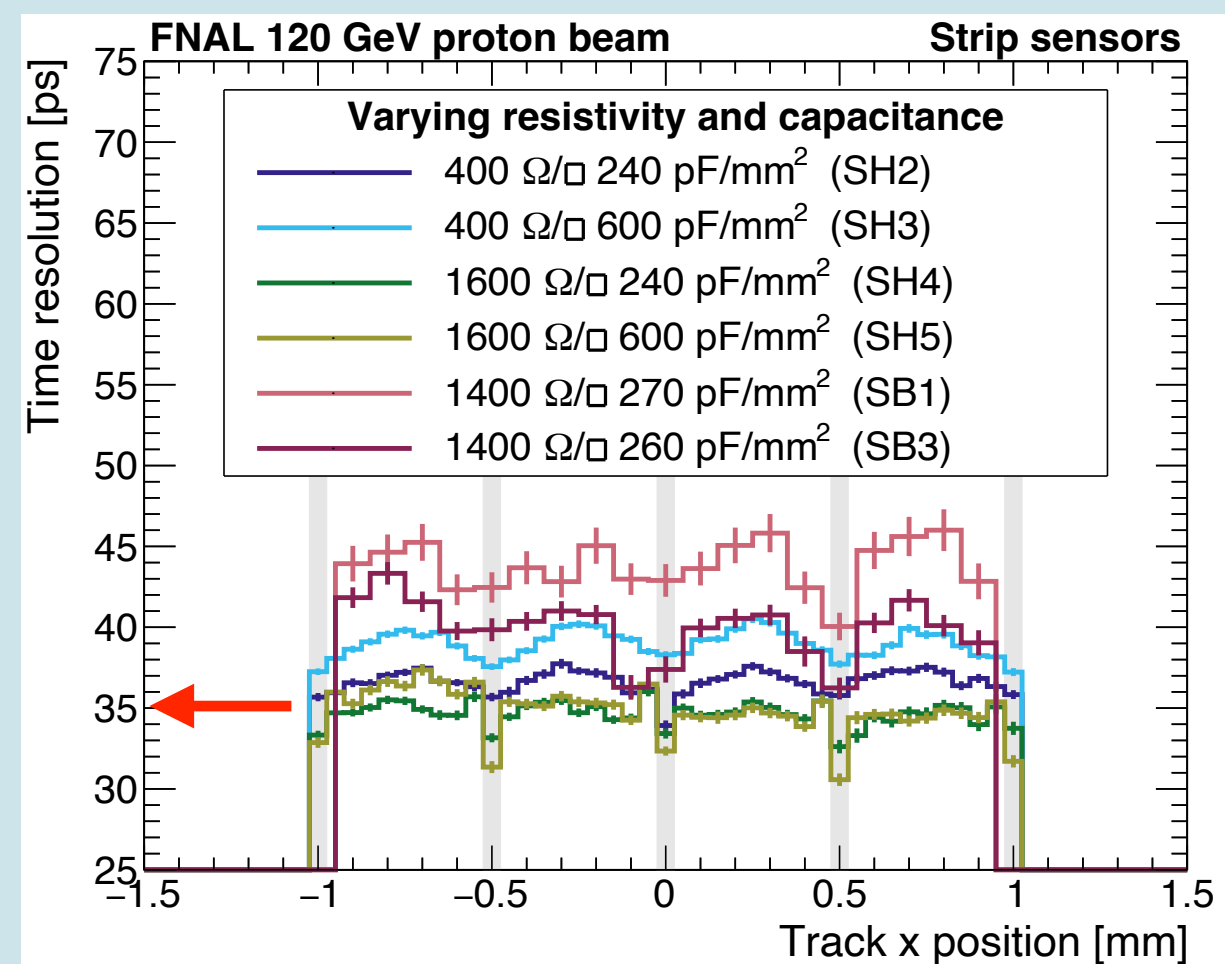
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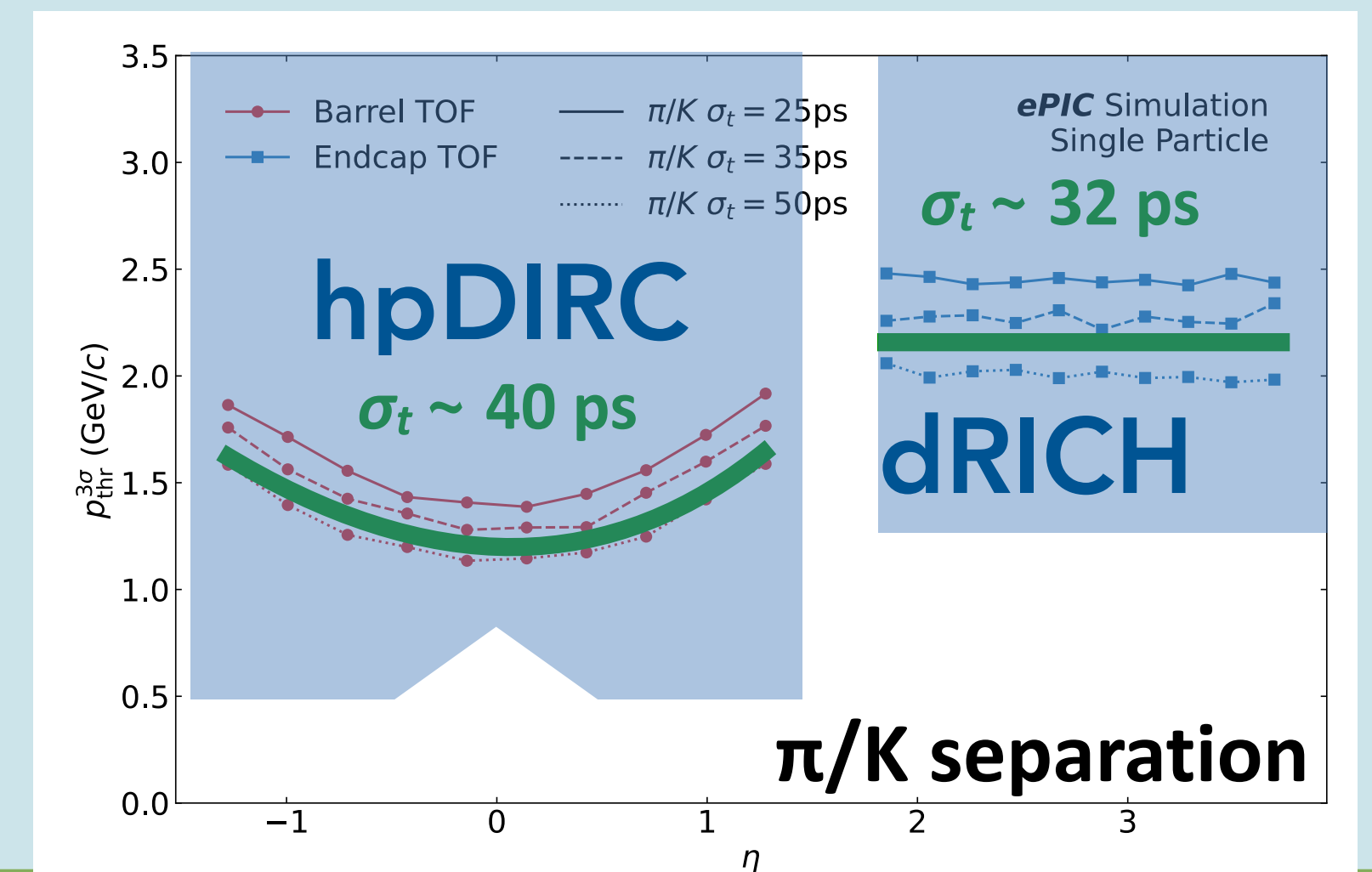
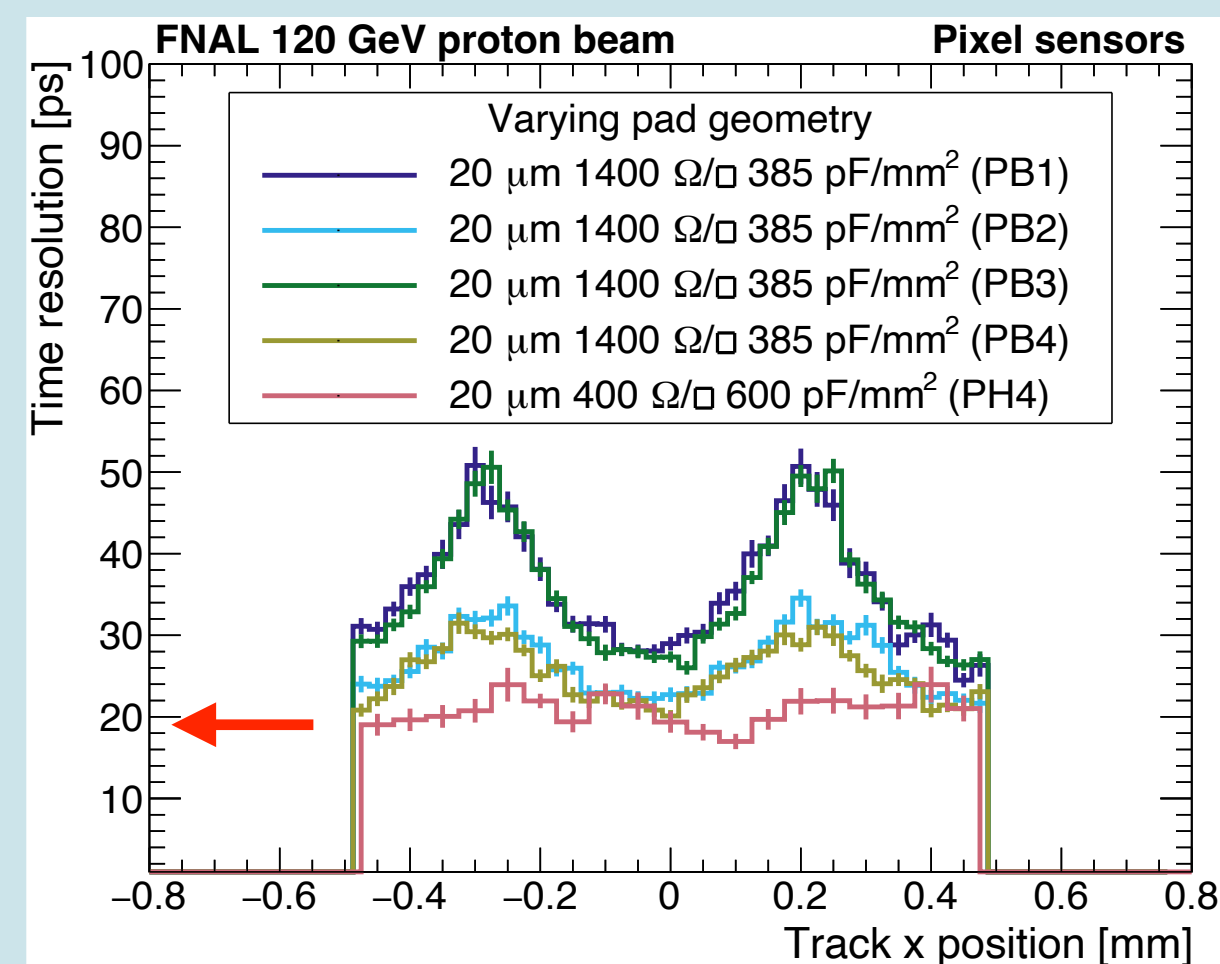
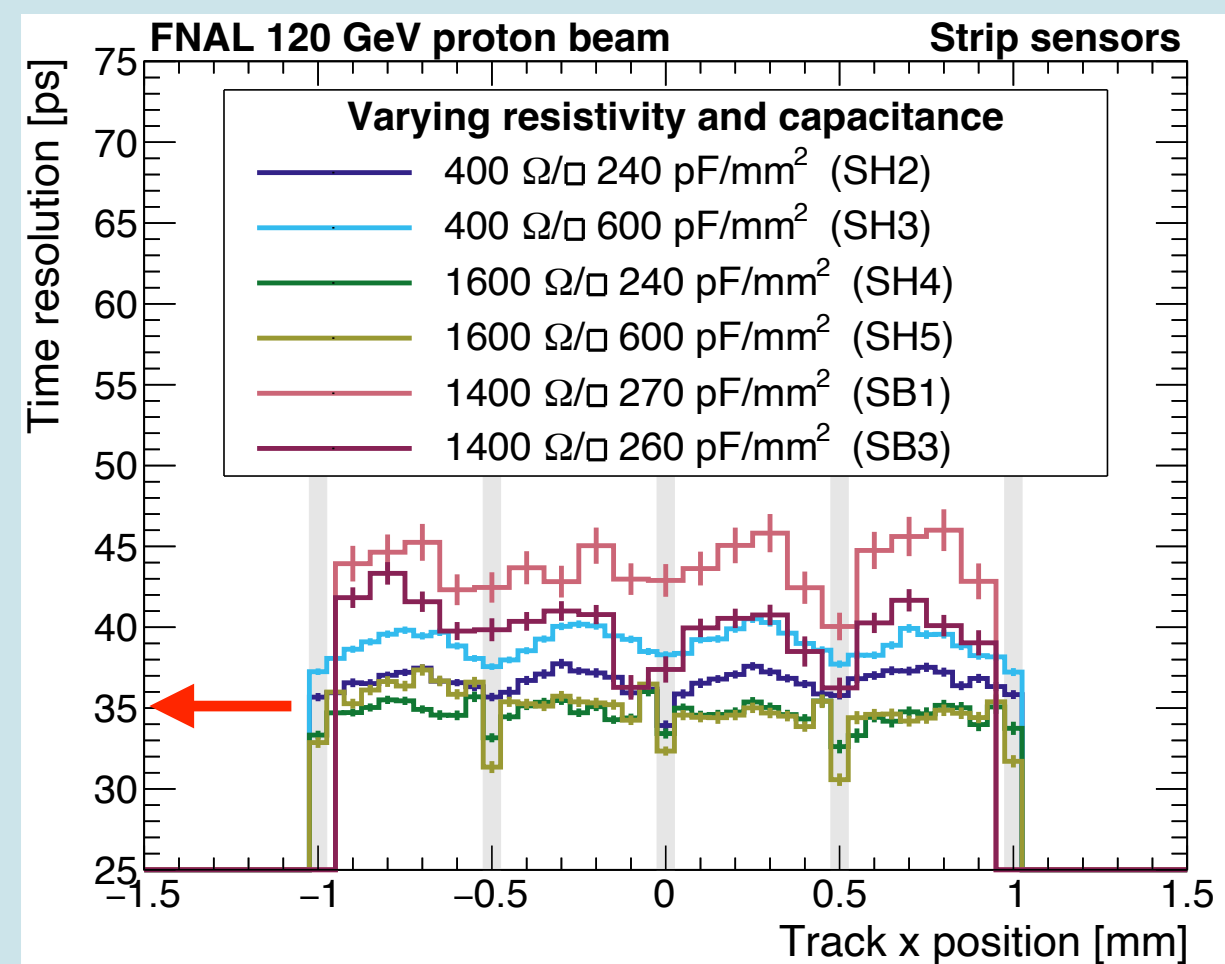
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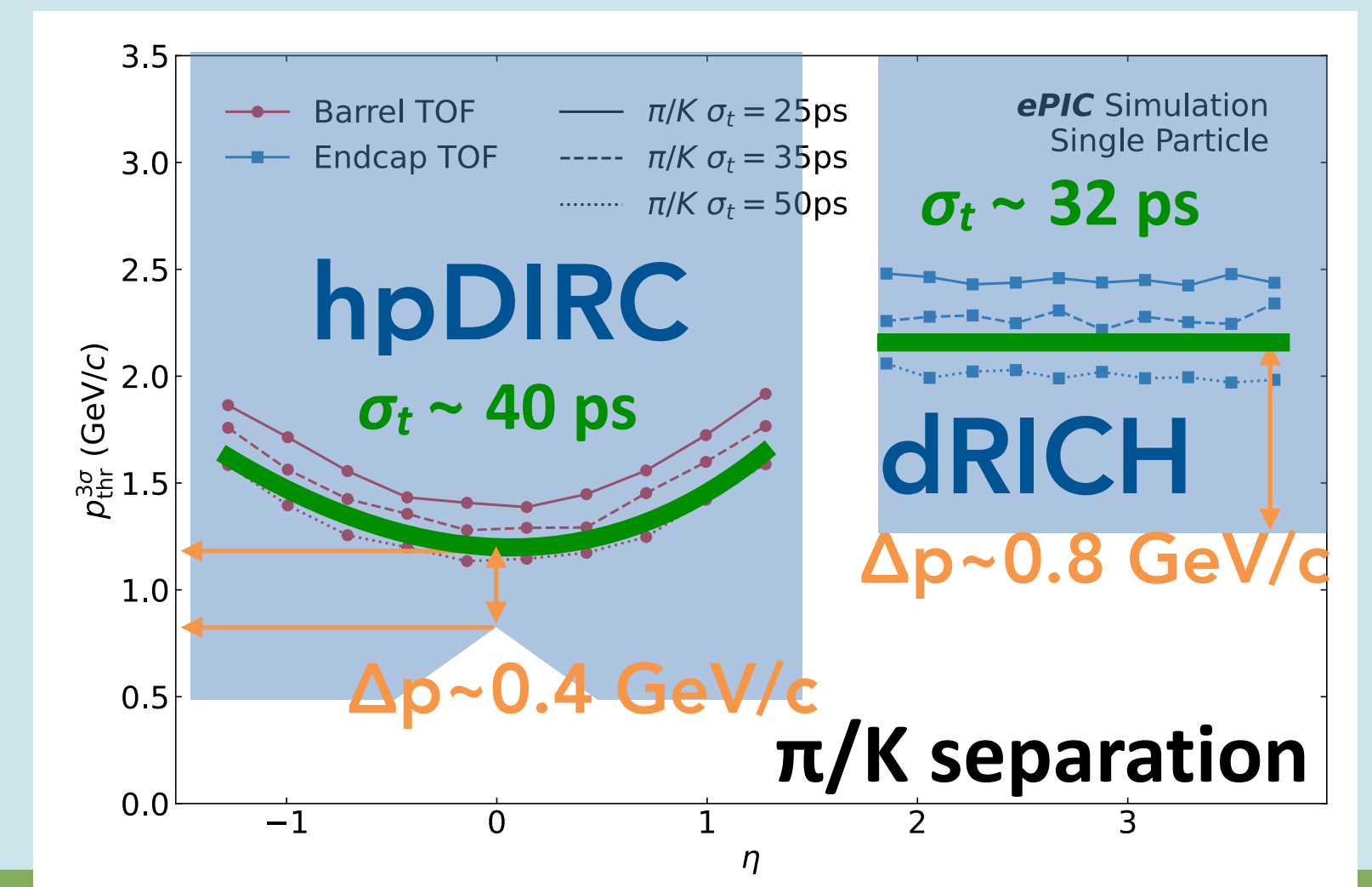
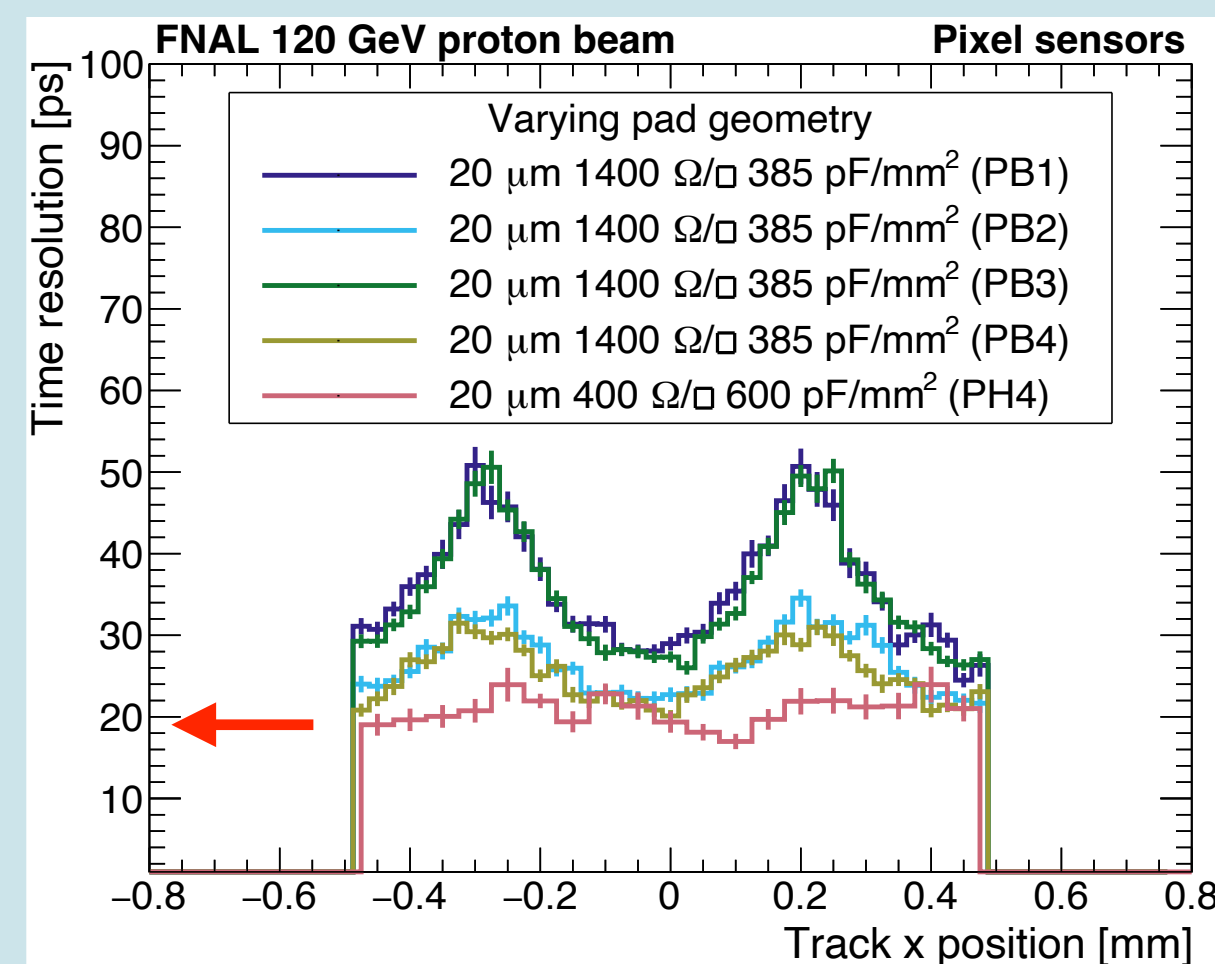
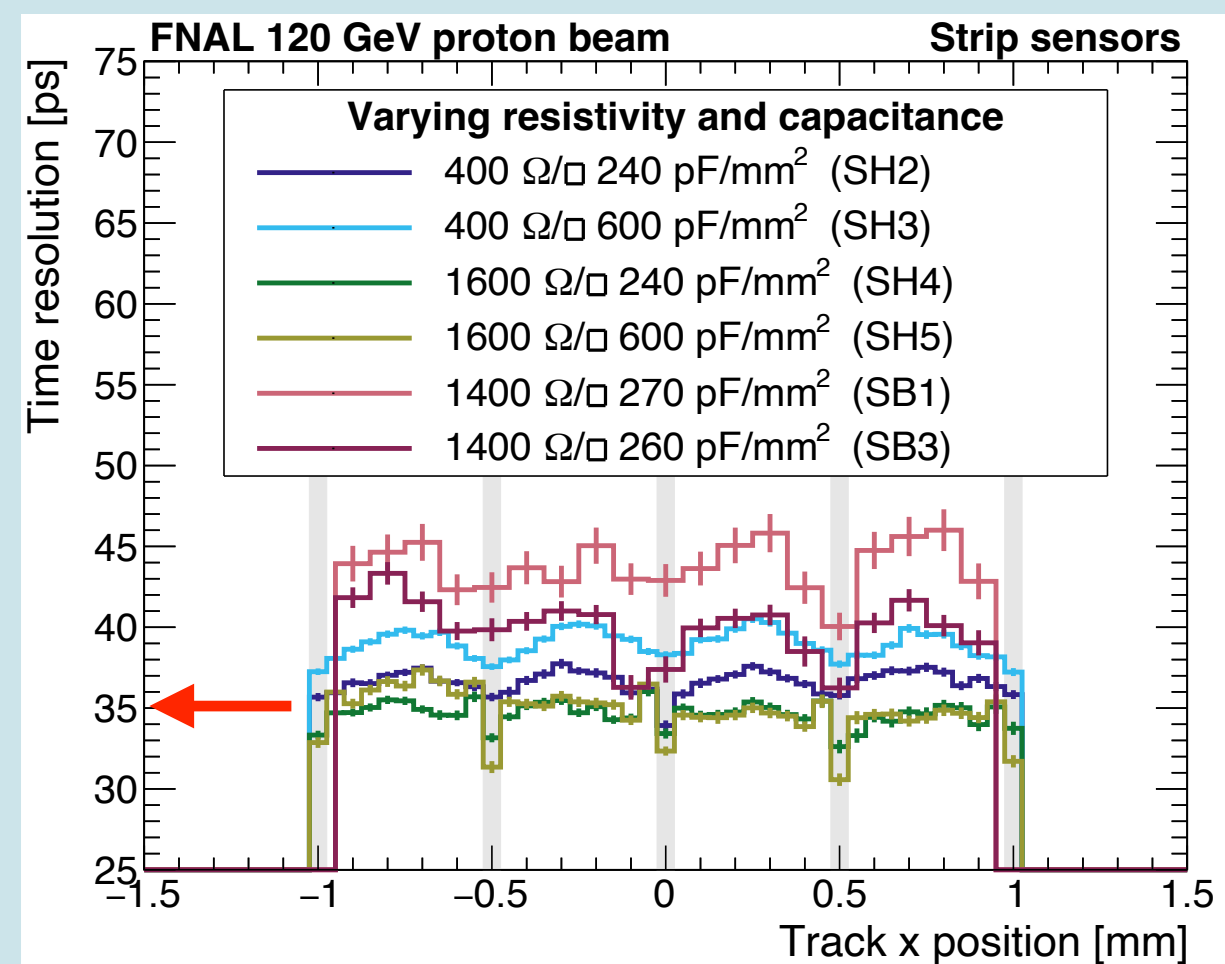
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 - **$\Delta p \sim 0.4$ GeV/c and $\Delta p \sim 0.8$ GeV/c are enough for barrel and forward, respectively?**

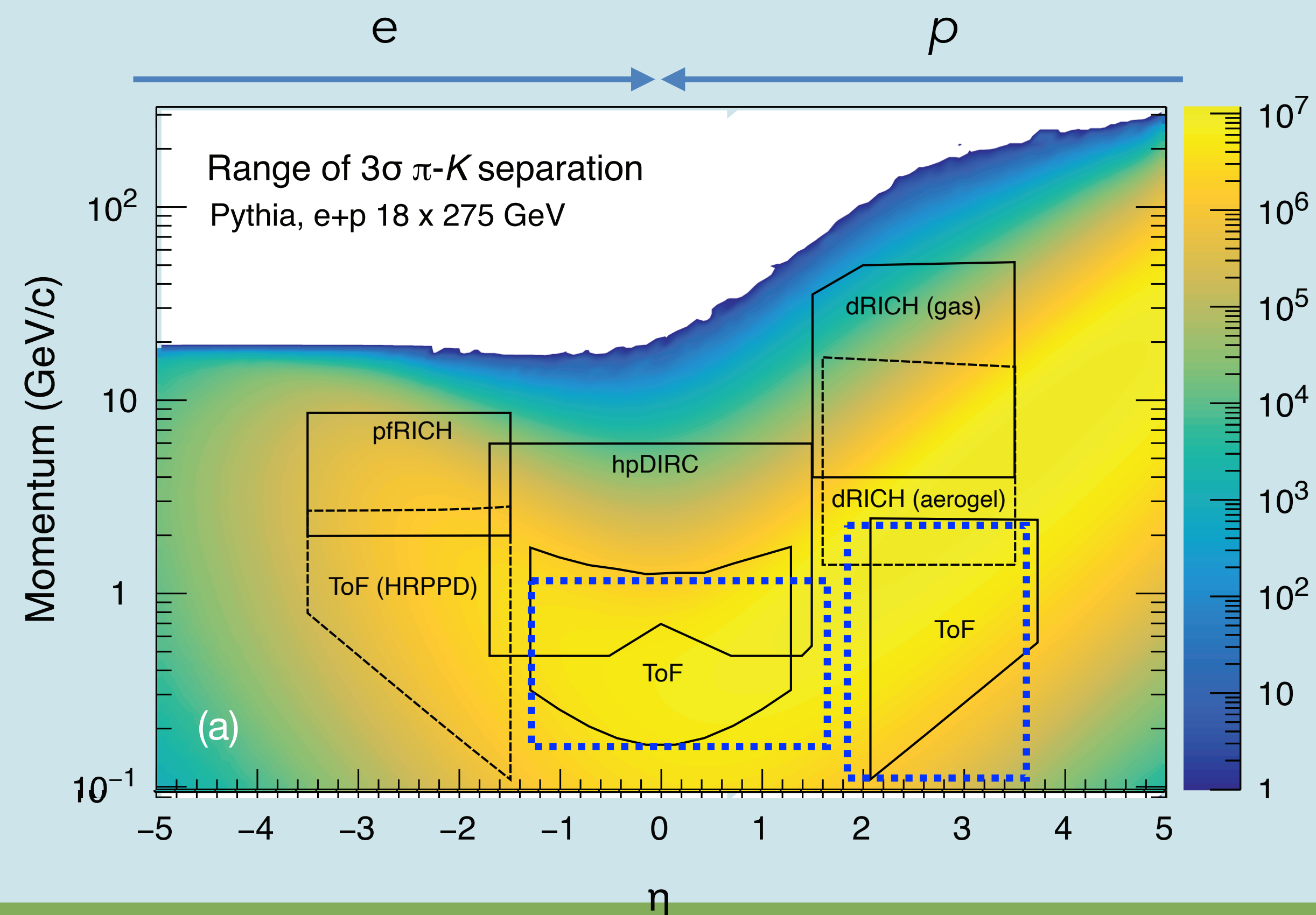


TOF position

- Change the TOF position is under discussion due to the global engagement ring position

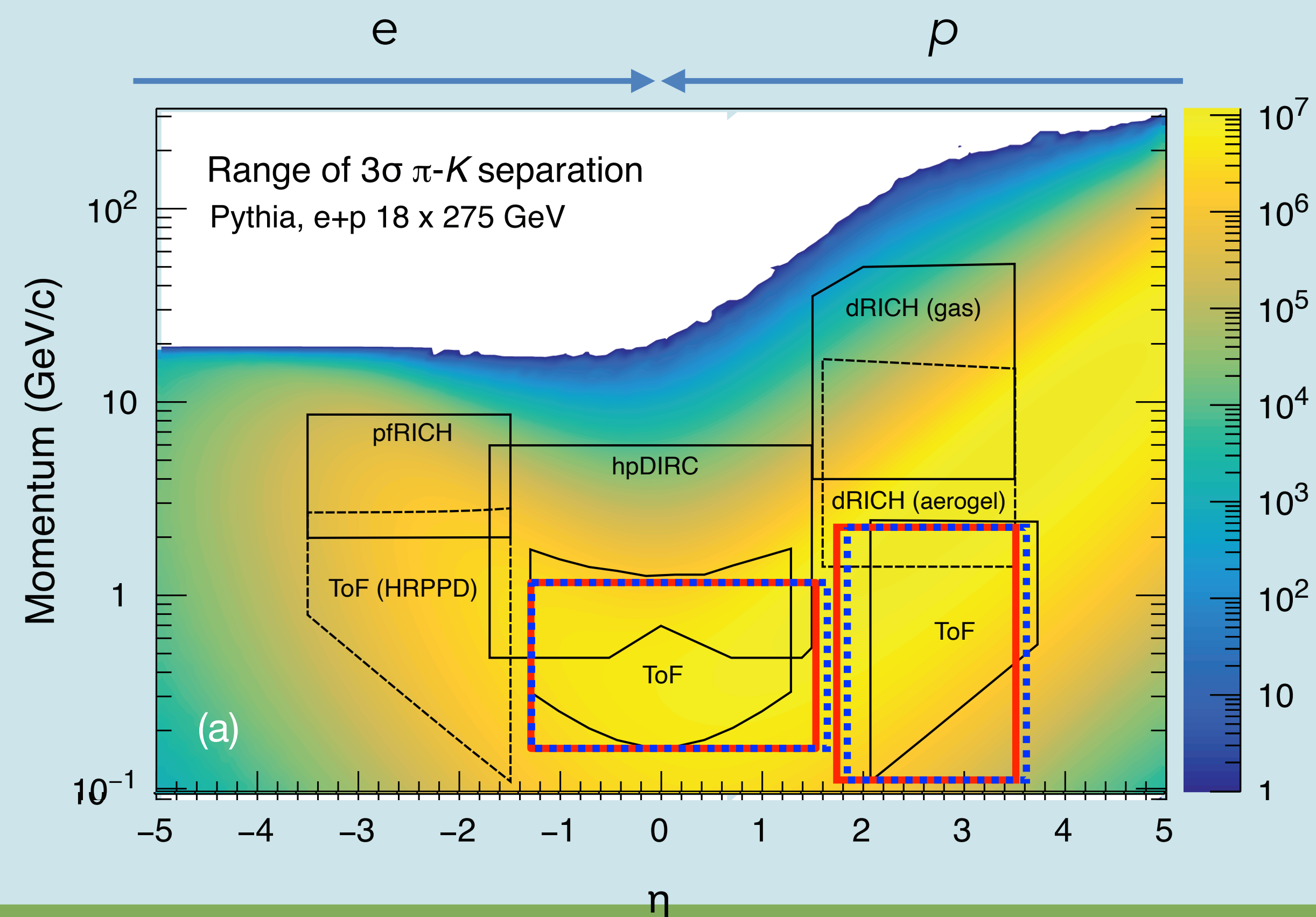
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 - $-112.5\text{cm} < z < 176.5\text{ cm} \rightarrow -112.5\text{cm} < z < 155.0\text{ cm}$
 - $-1.33 < \eta < 1.74 \rightarrow \mathbf{-1.33 < \eta < 1.62}$
- FTOF shifted toward IP by 17.5 cm
 - $z = 185.0\text{ cm} \rightarrow z = 167.5\text{ cm}$
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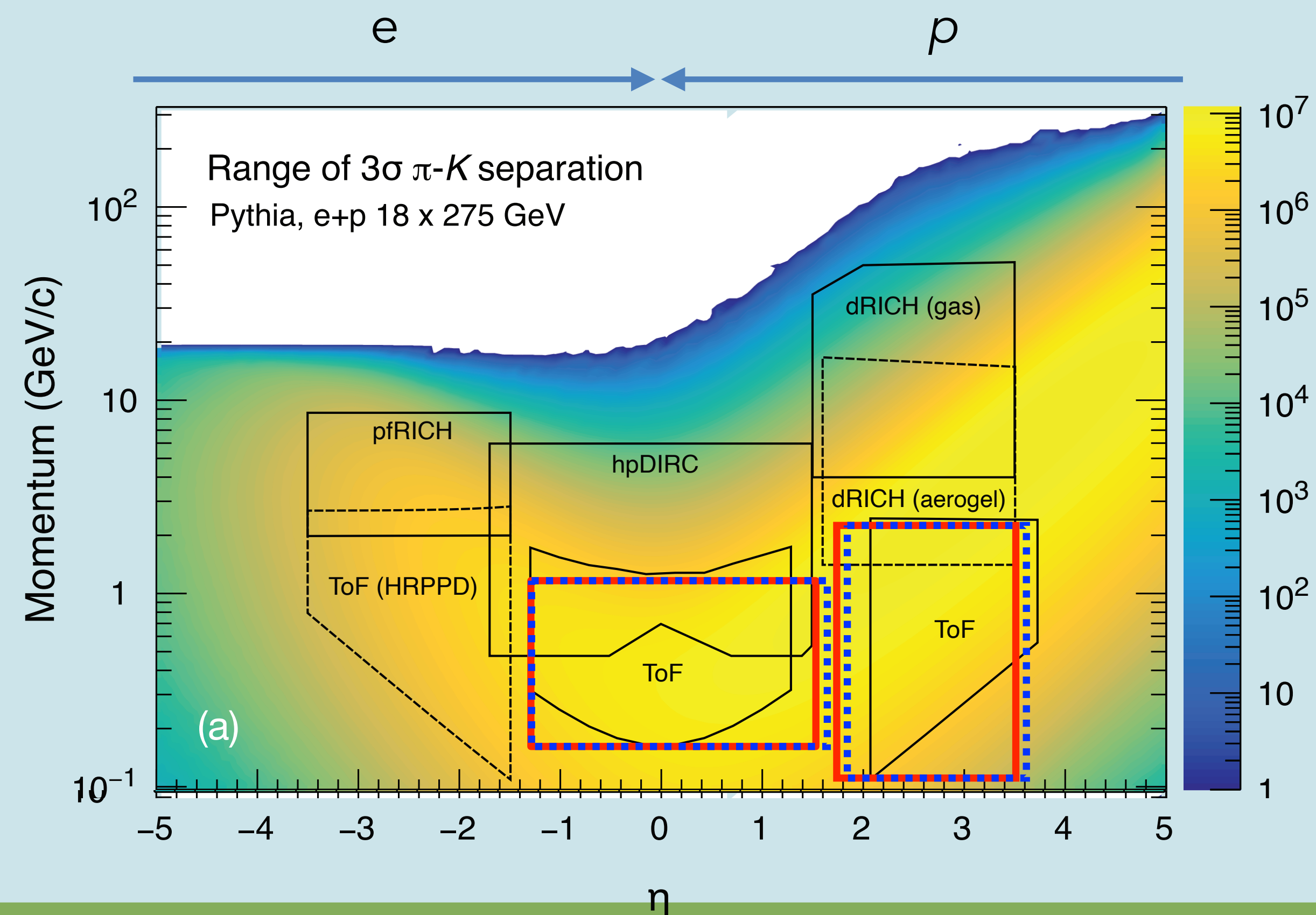
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- **FTOF position is closer than before**
 - **PID performance is affected just a bit...**

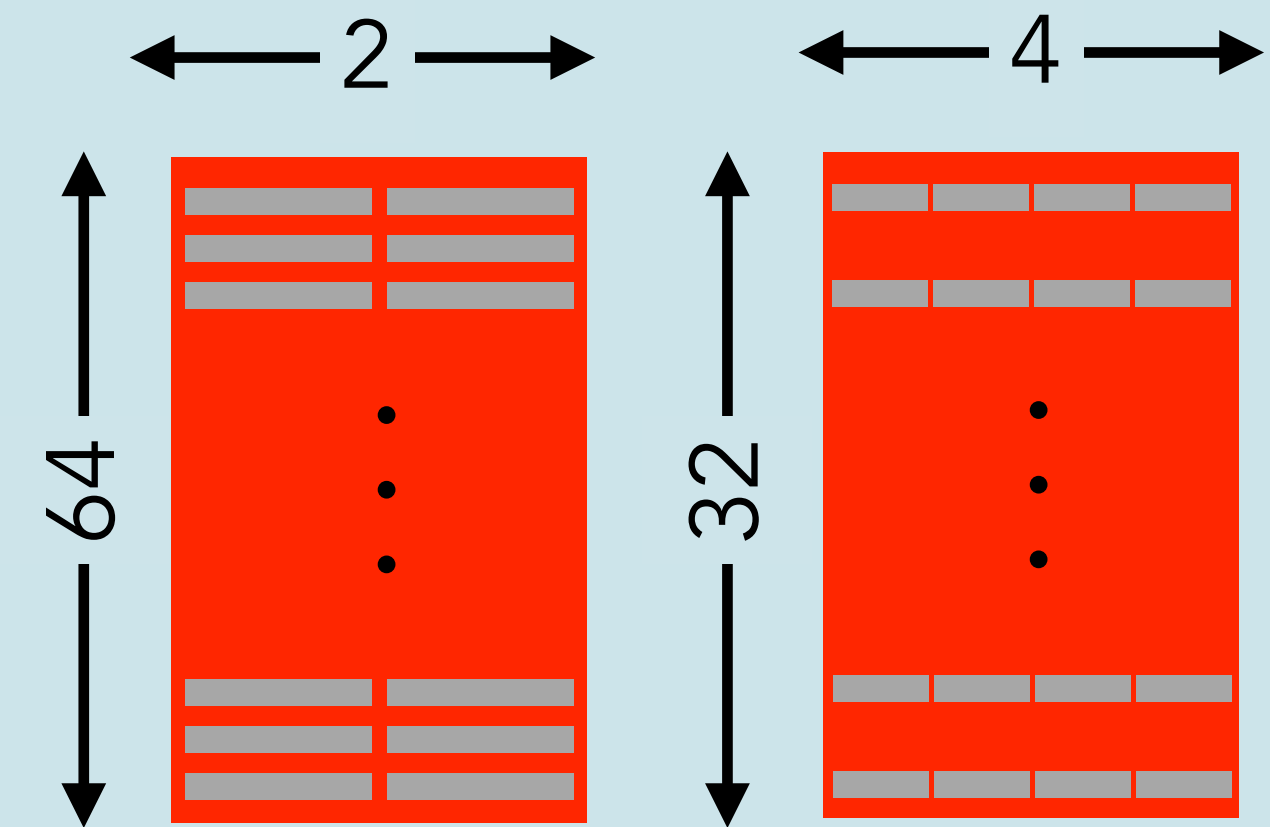


Future activity

- Develop sensors more suitable for EIC

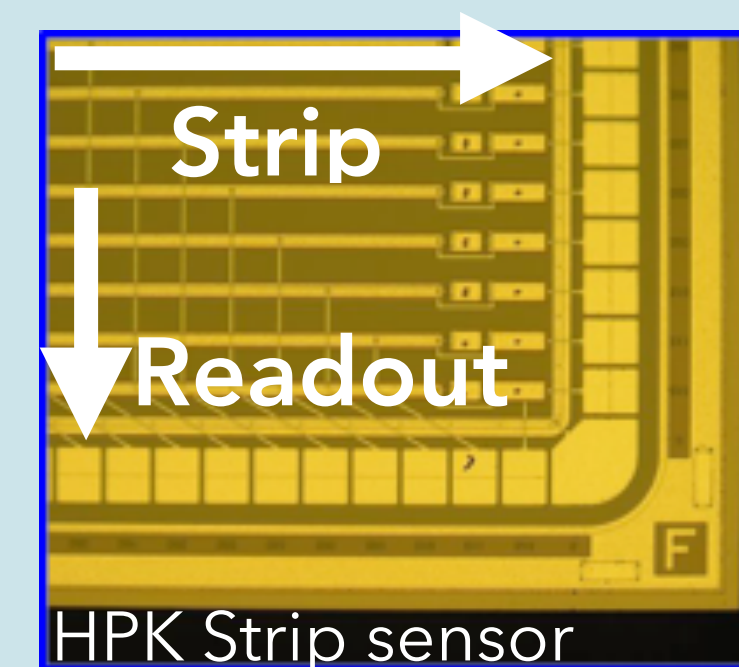
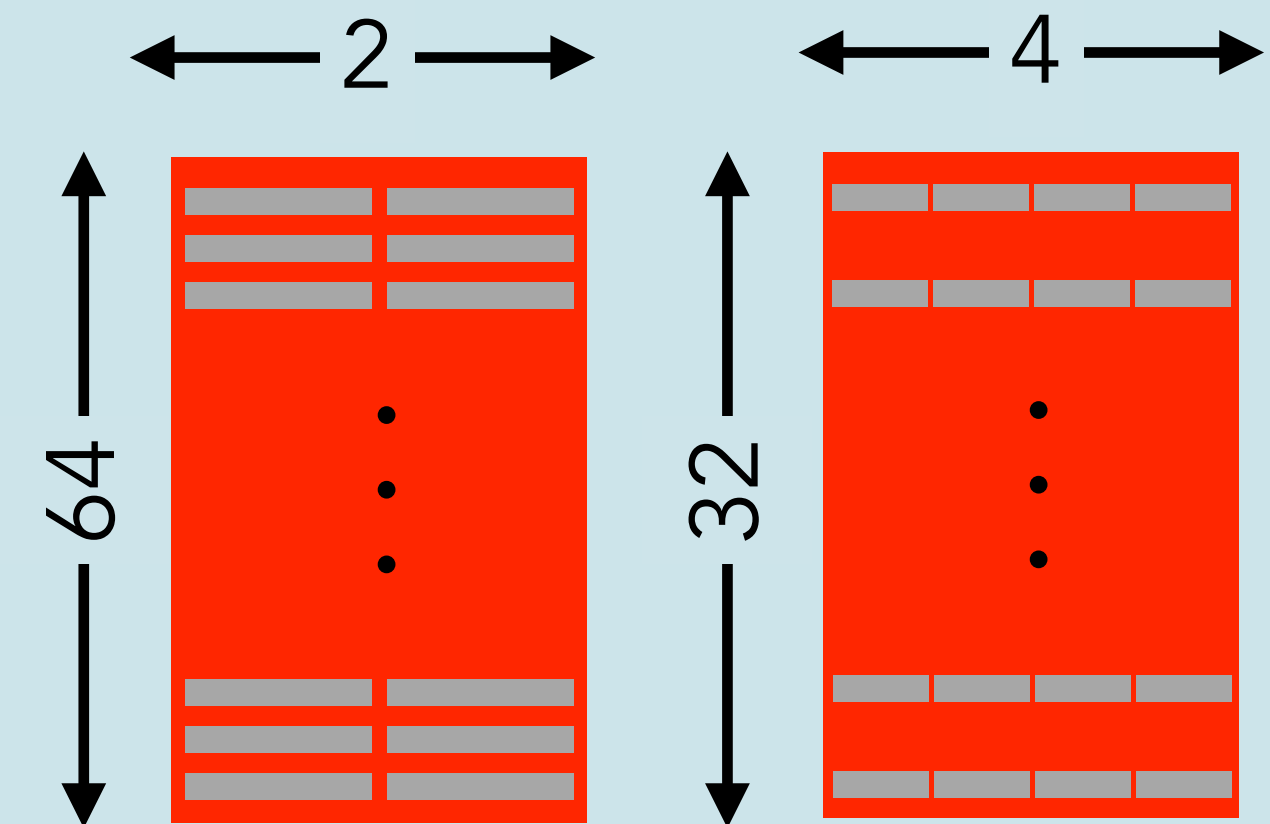
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 - The current sensor has excellent positional resolution (15~20 μm), so we would like to investigate the possibility of sacrificing a little of this to improve timing resolution
 - For example, 0.5 \rightarrow 1mm pitch and 10 \rightarrow 5mm strip length

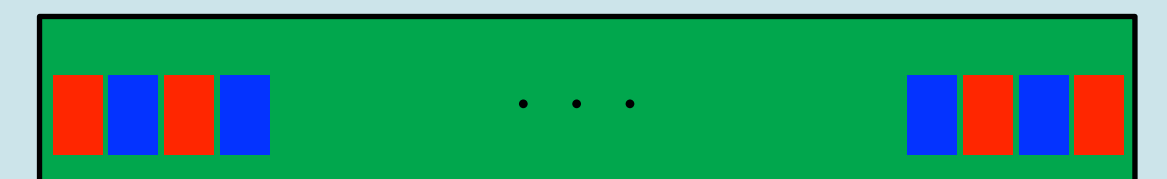


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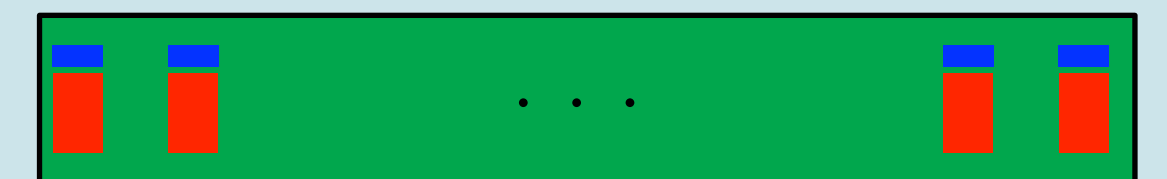
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 - For example, 0.5 \rightarrow 1mm pitch and 10 \rightarrow 5mm strip length
- We will challenge to deploy the double metal layer
 - One side case has 156 μm pitch, but the double-side case 312 μm
 - ASIC can be put on the side of the sensor \rightarrow expand design possibility



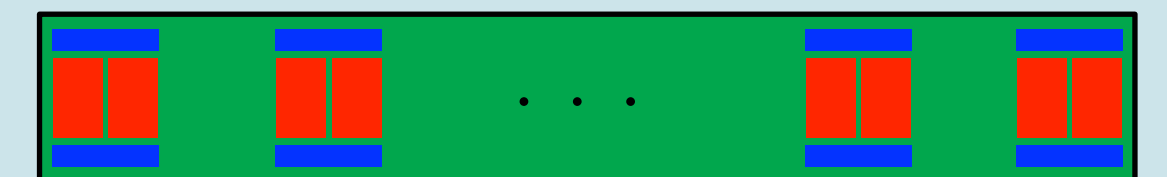
Baseline



Single-side double metal



Double-side double metal



Summary

- TOF covers at low momentum range PID
- The sensor design baseline for BTOF has been changed
- Technological issues may lead to changes in the kinematic range covered, but not significantly
- We continue developing sensors more suitable for EIC

Extra slides

What we want to clarify today

What amount of BTOF material budget is allowed?

What is the kinematic range that TOF should measure?

Latest sensor performance

Beam test result at FNAL (from eRD112 FY24 report by FNAL, LBNL)

Strip type results

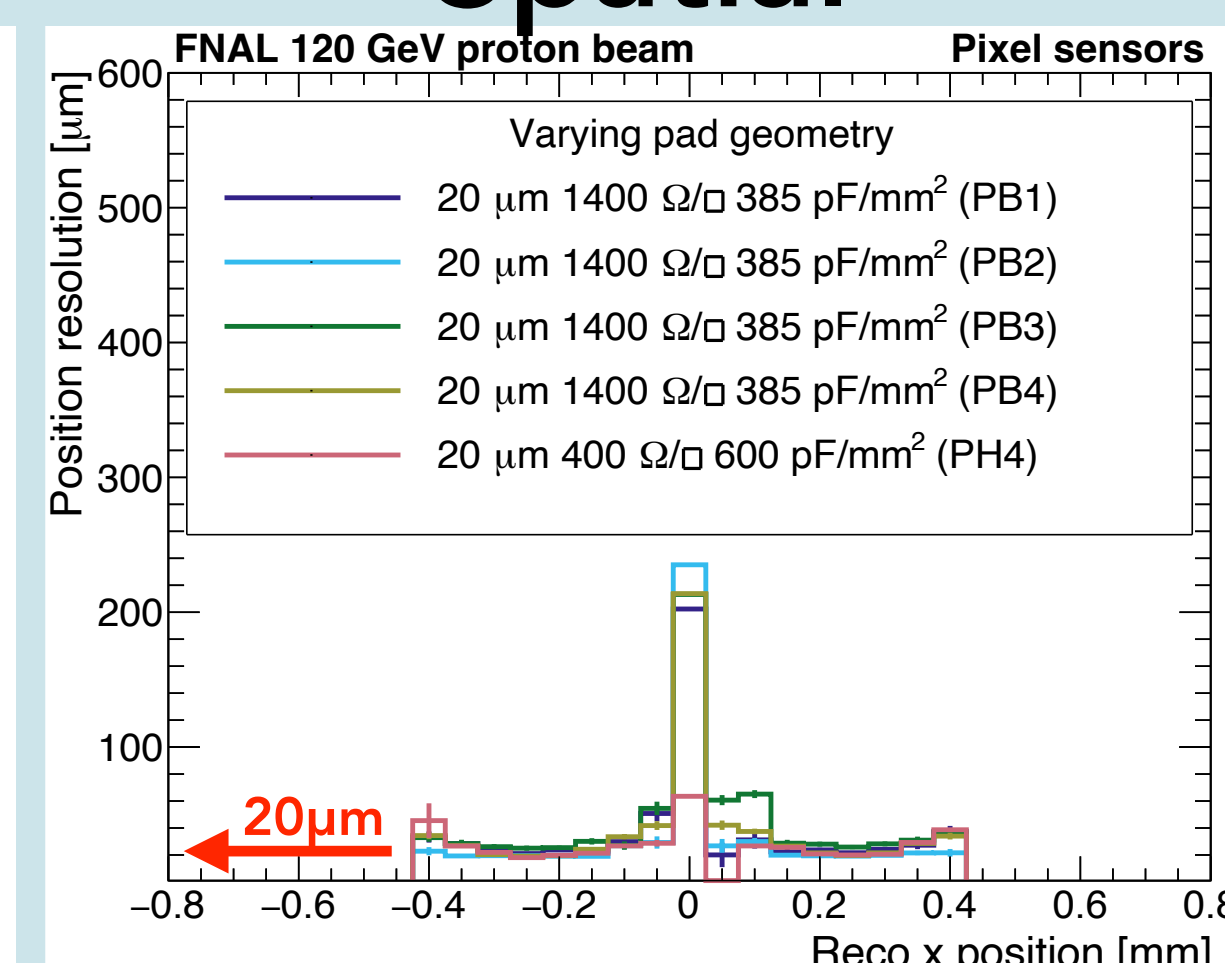
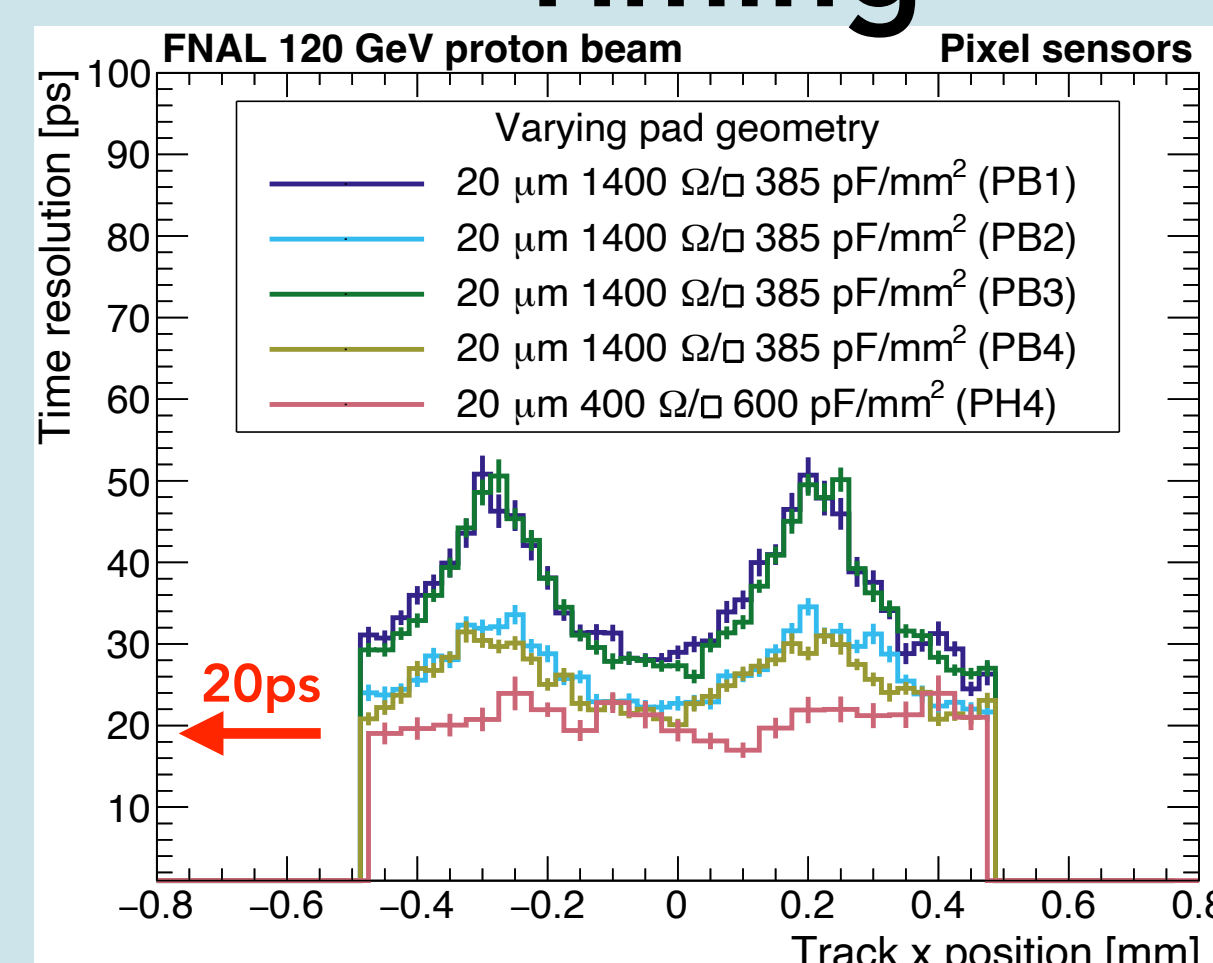
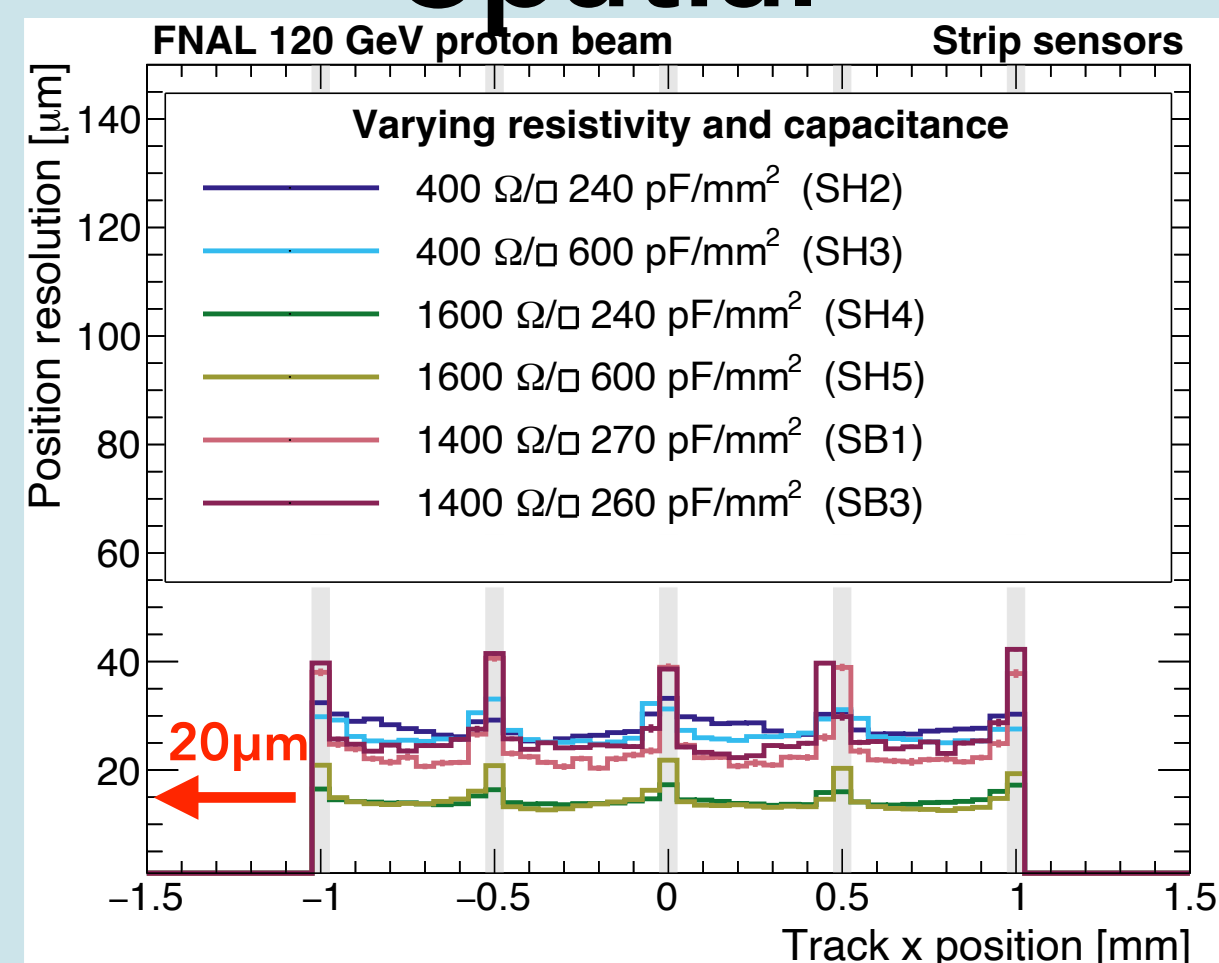
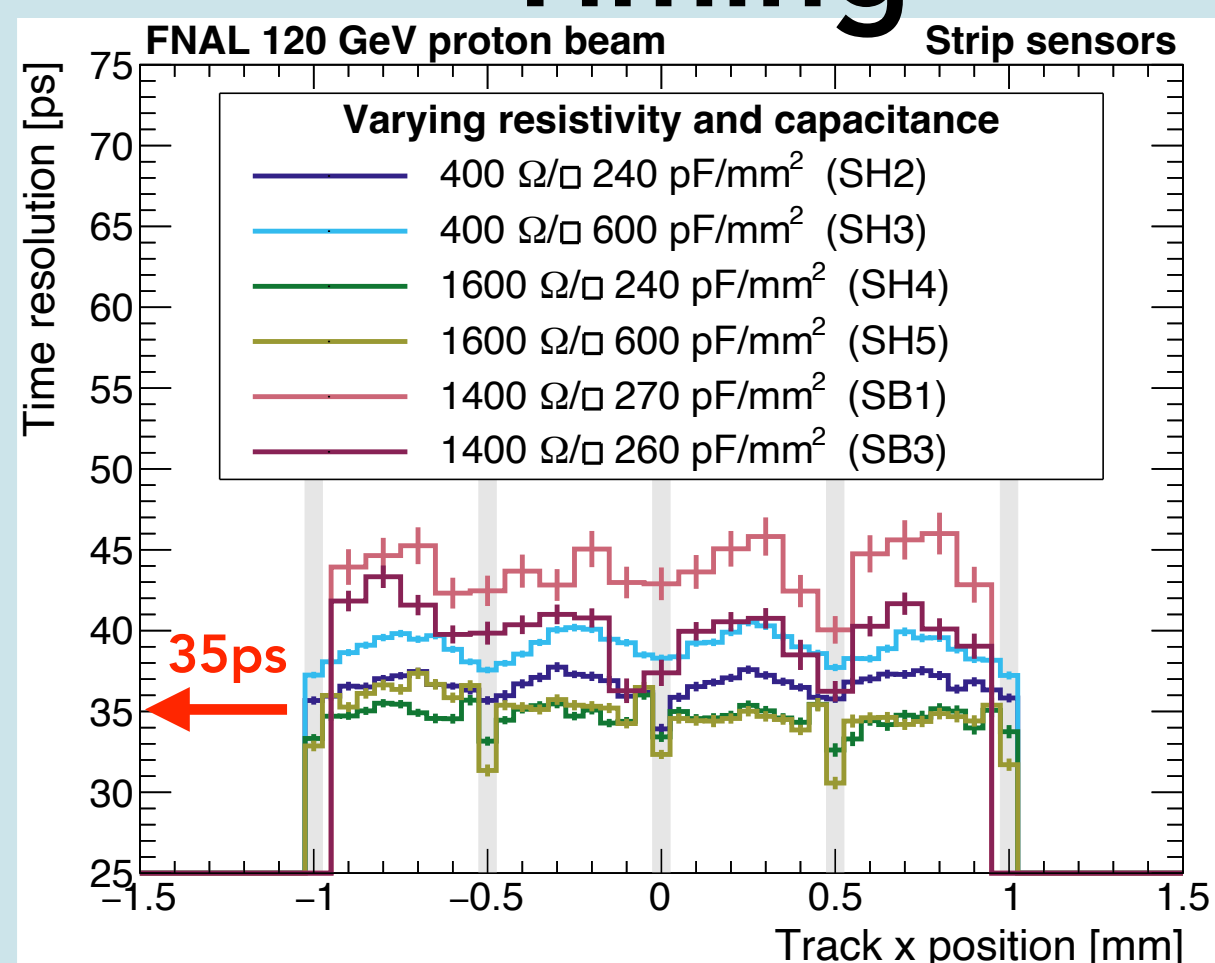
Timing

Spatial

Pixel type results

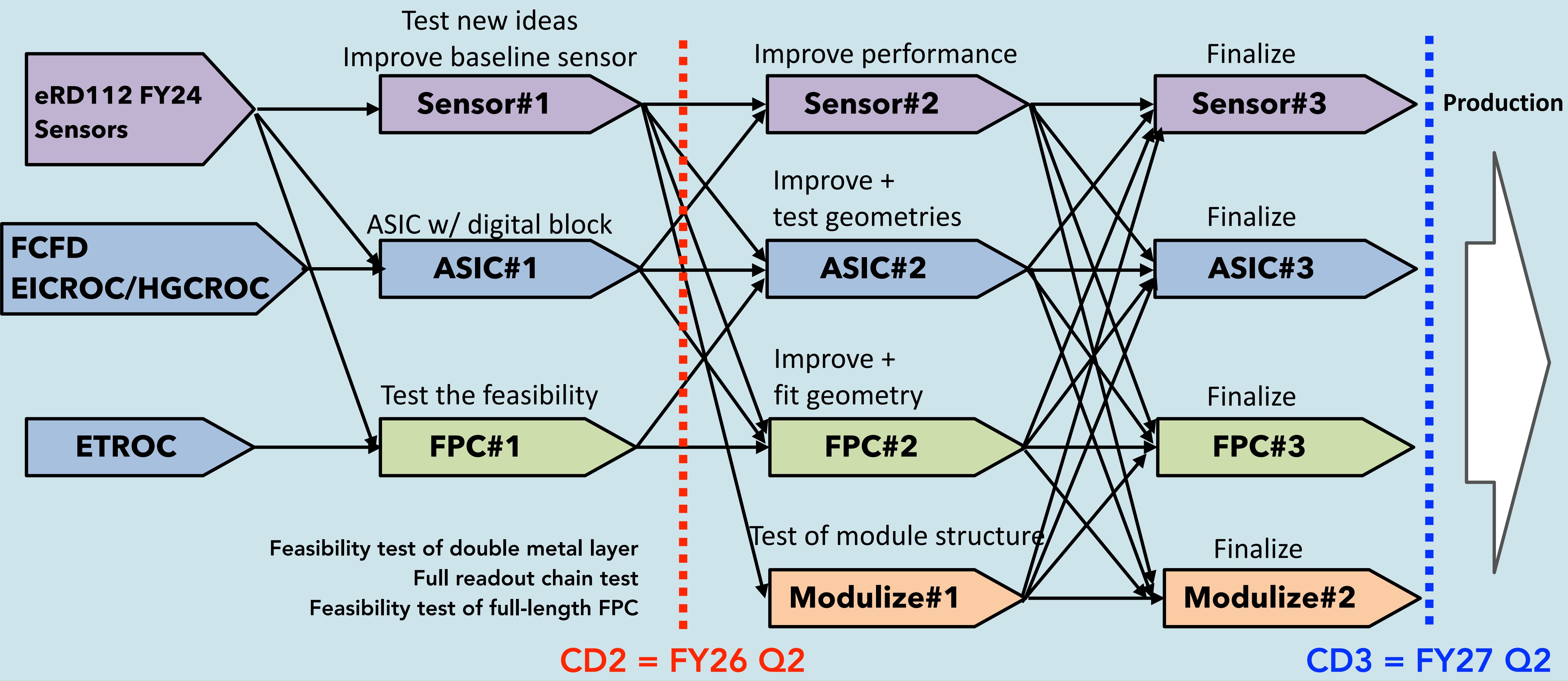
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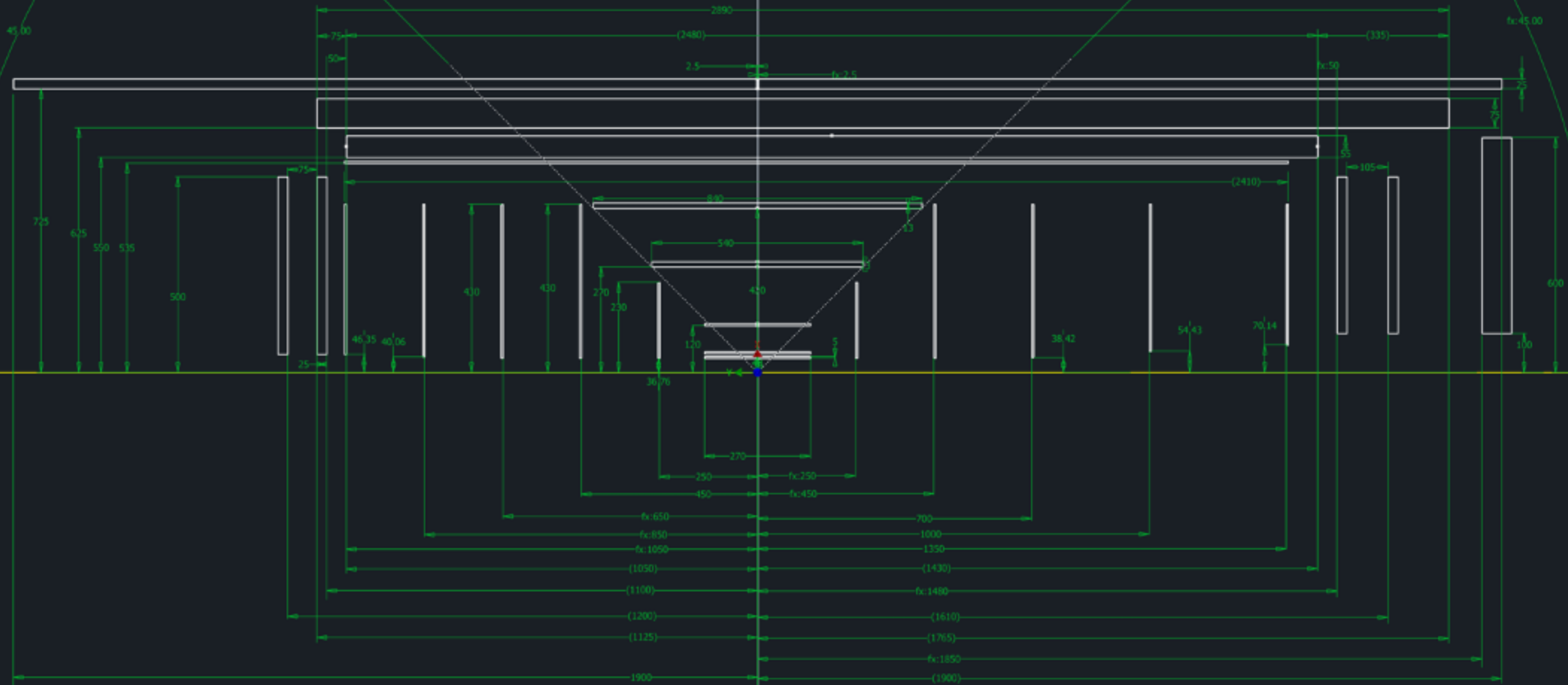


- HPK and BNL sensors show reasonable results in both strip and pixel types with the “BEST” bias voltage
 - The higher performance of time resolution should be achieved when considering the electronics jitter and T0 resolution
- The performances are under control and the next prototypes will have higher performance
- The sensors are still smaller than the sensors used in the experiment

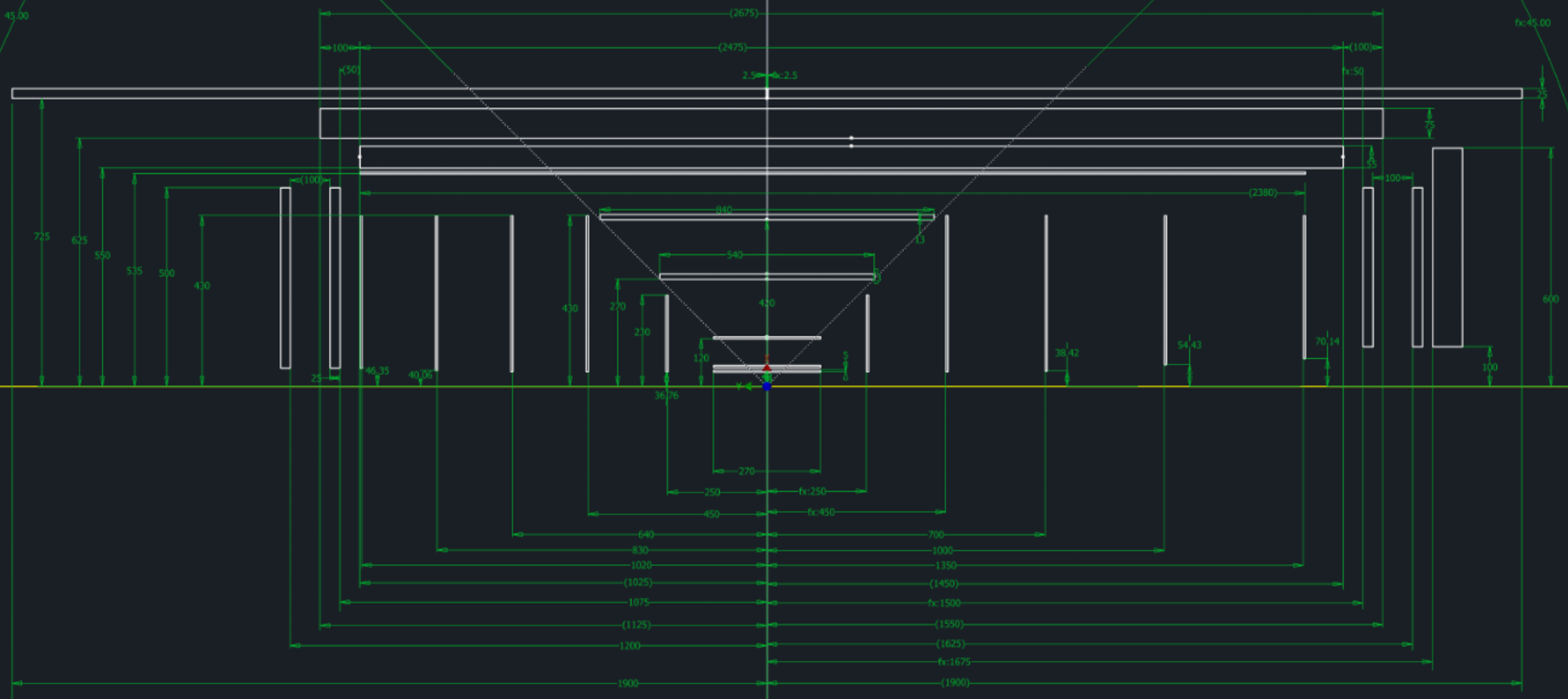
Roadmap (ver0)



CURRENT



PROPOSAL



What must be discussed in this meeting

- **What amount of BTOF material budget is allowed?**
 - Effect on the angle resolution on the hpDIRC surface
 - We have a dedicated workfest this afternoon, "Tracking Projections/Resolution @ hpDIRC" ([link](#))
- **What is the lower limit of time resolution performance?**
 - Best timing performance is $\Delta t_{\text{Sensor}} = 35 \text{ ps}$ → $\Delta t_{\text{BTOF}} = 43 \text{ ps}$ with $\Delta t_{\text{ASIC}} = 20 \text{ ps}$, and $\Delta t_{\text{T0}} = 15 \text{ ps}$
- **Is it possible to make a long and low-material budget FPC?**
 - What should we know and define? Another solution?
- **What is the best stave design?**
 - We must consider stave production yield and the line layout of the FPC
 - We may have to consider modularization to break it up into smaller pieces
- **What is the impact of the plan to shorten the BTOF by 21cm?**
- **How does the Japanese fund work with eRD109+eRD112?**
 - The Japanese government (MEXT) has decided to support BTOF (in FY25 ~\$2M)

